

# NCP1871

## Narrow Voltage DC Battery Charger

The NCP1871 is a NVDC switching battery charger designed for 2–3–4 battery cell applications such as ultra books or tablets. It is optimized for use with the mobile computing chipsets, and is also compatible with most mobile solutions.

The NCP1871 is designed around a full NMOS DC to DC controller that brings down the high voltage charger adapter voltage to a regulated system supply that is in the same range as the battery pack voltage. This limits the variation on the system supply voltage, and improves the efficiency of the core converters. The device includes a voltage droop monitor, charger adapter validation and blocking as well as an intelligent battery connection control. The adapter current, charge current and system current are closely monitored and an image is provided to the host. The NCP1871 is fully programmable through an I<sup>2</sup>C friendly SMBus Interface.

### Features

- SMBus Host-controlled NVDC–1 2S–4S Battery Charge Controller
- Instant-on Works with No Battery or Deeply Discharged Battery
- Automatic Supplement Mode with BATFET Control
- Battery Removal Sensor
- Programmable Switching Frequency
- SMBUS Clock up to 400 kHz (I<sup>2</sup>C compatible)
- Programmable Charge Current, Charge Voltage, Input Current Limit with Interrupt Management
  - ◆ ±0.5% Charge Voltage Regulation up to 18.08 V
  - ◆ ±3% Input/Charge Current Regulation up to 8.064 A
- Support Battery LEARN Function
- Support Shipping Mode and Hard System Reset
- Ultra-Low Quiescent Current of 10 µA at OFF Mode and High PFM Light Load Efficiency 80% at 20 mA Load to Meet Energy Star and ErP Lot6
- Full NMOS Solution
- Current and Power Monitoring
- 3.5 mm x 3.5 mm QFN–20 Package
- These Devices are Pb-Free, Halogen Free/BFR Free and are RoHS Compliant

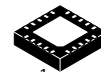
### Typical Applications

- Ultrabook
- Notebook
- Tablet PC



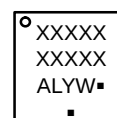
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1  
**QFN20**  
**MN SUFFIX**  
**CASE 485CP**

### MARKING DIAGRAM



XXXXX = Specific Device Code

A = Assembly Location

L = Wafer Lot

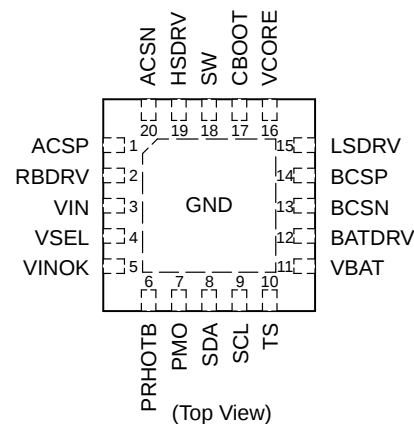
Y = Year

W = Work Week

■ = Pb-Free Package

(Note: Microdot may be in either location)

### PIN CONFIGURATION



### ORDERING INFORMATION

| Device       | Package            | Shipping <sup>†</sup> |
|--------------|--------------------|-----------------------|
| NCP1871MNTXG | QFN20<br>(Pb-Free) | 3000 / Tape & Reel    |

<sup>†</sup>For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

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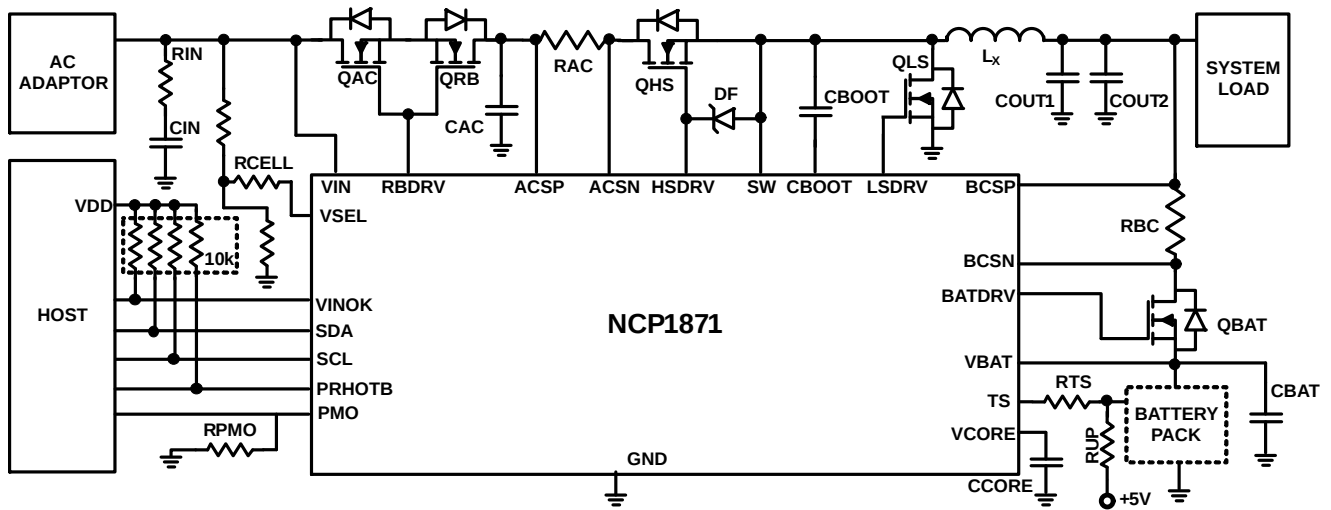


Figure 1. Typical Application Circuit

# NCP1871

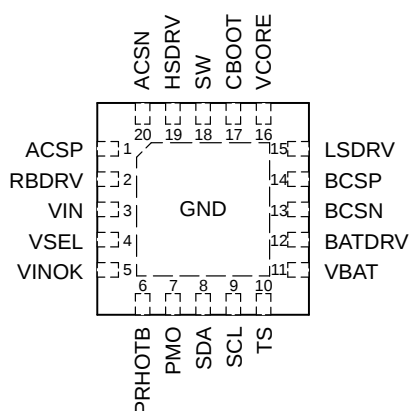


Figure 2. Pin Out Description (Top View)

Table 1. PIN FUNCTIONAL DESCRIPTION

| Pin | Name       | Type              | Description                                                                                                                                                                                                           |
|-----|------------|-------------------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 1   | ACSP       | ANALOG INPUT      | Charger Adapter Current Sense Positive terminal. Use a 10 mΩ sense resistor RAC. Bypass ACSP with a 10 μF capacitor                                                                                                   |
| 2   | RBDIV      | ANALOG OUTPUT     | Reverse Blocking FET Driver. Drives the gate of the RBFET NMOS. Can also drive gate optional ACFET NMOS.                                                                                                              |
| 3   | VIN        | ANALOG INPUT      | Charger Adapter Input. Bypass with a Damping network                                                                                                                                                                  |
| 4   | VSEL       | ANALOG INPUT      | Adapter detection input. Program adapter valid input threshold by connecting a resistor divider from adapter input to VSEL pin to GND pin. Connect a serial resistance of 220 kΩ to select 3–4 Cells default setting. |
| 5   | VINOK      | OPEN DRAIN OUTPUT | Charge Adapter Valid Output. Signals the VIN is within the target range. Open drain output requiring an external pull up. Also use for short pulse signal interrupt generation                                        |
| 6   | PRHOTB     | OPEN DRAIN OUTPUT | Processor Hot Signal Output. Pulled low to reduce processor speed based on BCSP.                                                                                                                                      |
| 7   | PMO        | ANALOG OUTPUT     | Current based indication of system power. Amplified version of the adapter power, the battery power or sum of both.                                                                                                   |
| 8   | SDA        | DIGITAL IN/OUT    | Control Bus Data Line.                                                                                                                                                                                                |
| 9   | SCL        | DIGITAL INPUT     | Control Bus Clock Line.                                                                                                                                                                                               |
| 10  | TS         | ANALOG INPUT      | Battery Presence Detection. Connect this pin to the battery thermistor sensor.                                                                                                                                        |
| 11  | VBAT       | ANALOG IN/OUT     | Battery Connection. Bypass with at least 10 μF capacitor.                                                                                                                                                             |
| 12  | BATDRV     | ANALOG OUTPUT     | Battery FET Driver.                                                                                                                                                                                                   |
| 13  | BCSN       | ANALOG INPUT      | Battery Current Sense Negative Terminal. Use a 10 mΩ sense resistor RBC.                                                                                                                                              |
| 14  | BCSP       | ANALOG INPUT      | Battery Current Sense Positive Terminal. Use a 10 mΩ sense resistor RBC.                                                                                                                                              |
| 15  | LSDRV      | ANALOG OUTPUT     | Low Side Switch Driver. Drives the gate of the DC to DC low side NMOS.                                                                                                                                                |
| 16  | VCORE      | ANALOG OUTPUT     | Core Voltage. Do not connect load on this pin. Bypass with a 2.2 μF capacitor                                                                                                                                         |
| 17  | CBOOT      | ANALOG IN/OUT     | Bootstrap Capacitor Connection.                                                                                                                                                                                       |
| 18  | SW         | ANALOG OUTPUT     | Switching Node. Connection to the 2.2 μH inductor.                                                                                                                                                                    |
| 19  | HSDRV      | ANALOG OUTPUT     | High Side Switch Driver. Drives the gate of the DC to DC high side NMOS. Supplied from the bootstrap capacitor.                                                                                                       |
| 20  | ACSN       | ANALOG INPUT      | Charger Adapter Current Sense Negative terminal. Use a 10 mΩ sense resistor RAC.                                                                                                                                      |
| –   | EXPOSE PAD | GROUND            | Internally connected to ground                                                                                                                                                                                        |

**Table 2. MAXIMUM RATINGS**

| Rating                                                                                               | Symbol                             | Value                | Unit    |
|------------------------------------------------------------------------------------------------------|------------------------------------|----------------------|---------|
| V <sub>IN</sub> , RBD <sub>RV</sub> (Note 1)                                                         | V <sub>MR_AC</sub>                 | -0.3 to +30          | V       |
| ACSP, ACSN, HSD <sub>RV</sub> , SW, CBOOT, BCSP, BCSN, BATD <sub>RV</sub> , VBAT (Note 1)            | V <sub>MR_ACS</sub>                | -0.3 to +30          | V       |
| TS (Note 1)                                                                                          | V <sub>MR_DRP</sub>                | -0.3 to +7.0         | V       |
| CBOOT with respect to SW (JEDEC standard JESD22-A108)                                                | V <sub>MR_CBOOT</sub>              | -0.3 to +7.0         | V       |
| LSDRV, V <sub>CORE</sub> , PRHOTB, PMO, VINOK, VSEL (Note 1)                                         | V <sub>MR_LV</sub>                 | -0.3 to +7.0         | V       |
| Digital Input: SCL, SDA (Note 1)<br>Input Voltage<br>Input Current                                   | V <sub>DG</sub><br>I <sub>DG</sub> | -0.3 to +7.0 V<br>20 | V<br>mA |
| Human Body Model (HBM) ESD Rating are (Note 2)                                                       | ESD HBM                            | 1500                 | V       |
| Charged Device Model (CDM) ESD Rating are (Note 2)                                                   | ESD CDM                            | 750                  | V       |
| Latch up Current (Note 3):<br>All Digital pins( V <sub>DG</sub> )<br>VINOK, VSEL<br>All others pins. | I <sub>LU</sub>                    | ±10<br>±30<br>±100   | mA      |
| Storage Temperature Range                                                                            | T <sub>STG</sub>                   | -65 to + 150         | °C      |
| Maximum Junction Temperature (Note 4)                                                                | T <sub>J</sub>                     | -40 to + TSD         | °C      |
| Moisture Sensitivity (Note 5)                                                                        | MSL                                | Level 1              |         |

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

1. With Respect to GND. According to JEDEC standard JESD22-A108.
2. This device series contains ESD protection and passes the following tests: Human Body Model (HBM) ±1.5 kV per JEDEC standard: JESD22-A114. Charged Device Model (CDM) ±750 V per JEDEC standard: JESD22-C101.
3. Latch up Current Maximum Rating: ±100 mA or per ±10 mA JEDEC standard: JESD78 class II.
4. A thermal shutdown protection avoids irreversible damage on the device due to power dissipation.
5. Moisture Sensitivity Level (MSL): 1 per IPC/JEDEC standard: J-STD-020.

**Table 3. OPERATING CONDITION**

| Symbol                                                                                      | Parameter                          | Conditions                                   | Min | Typ | Max               | Unit |
|---------------------------------------------------------------------------------------------|------------------------------------|----------------------------------------------|-----|-----|-------------------|------|
| V <sub>IN</sub>                                                                             | Operational Power Supply           |                                              | 4.5 |     | V <sub>INOV</sub> | V    |
| V <sub>DG</sub>                                                                             | Digital input voltage level        |                                              | 0   |     | 5.5               | V    |
| T <sub>A</sub>                                                                              | Ambient Temperature Range          |                                              | -40 | 25  | +85               | °C   |
| I <sub>SINK</sub>                                                                           | VINOK sink current                 |                                              |     |     | 10                | mA   |
| C <sub>IN</sub>                                                                             | Decoupling input capacitor         |                                              |     | 4.7 |                   | μF   |
| R <sub>IN</sub>                                                                             | Damping resistor                   |                                              |     | 2   |                   | Ω    |
| C <sub>AC</sub>                                                                             | Decoupling Switcher capacitor      |                                              |     | 10  |                   | μF   |
| C <sub>BOOT</sub>                                                                           | Bootstrap capacitor                |                                              |     | 100 |                   | nF   |
| C <sub>CORE</sub>                                                                           | Decoupling core supply capacitor   |                                              |     | 2.2 |                   | μF   |
| C <sub>OUT1</sub> , C <sub>OUT2</sub>                                                       | Decoupling system capacitor        |                                              |     | 47  |                   | μF   |
| L <sub>X</sub>                                                                              | Switcher Inductor                  |                                              |     | 2.2 |                   | μH   |
| R <sub>AC</sub> , R <sub>BC</sub>                                                           | Current sense resistor             |                                              |     | 10  |                   | mΩ   |
| R <sub>DSONQRB</sub> , R <sub>DSONQHS</sub> ,<br>R <sub>DSONQLS</sub> , R <sub>DSONQB</sub> | RDSON resistance                   | N-channel<br>MOSFET<br>V <sub>GS</sub> = 5 V |     | 10  |                   | mΩ   |
| C <sub>GQRB</sub> , C <sub>GQHS</sub> , C <sub>GQLS</sub> , C <sub>GQB</sub>                | Total Gate Charge                  |                                              |     | 10  |                   | nC   |
| R <sub>θJA</sub>                                                                            | Thermal Resistance Junction to Air | (Notes 4 and 6)                              |     | 50  |                   | °C/W |
| T <sub>J</sub>                                                                              | Junction Temperature Range         |                                              | -40 | 25  | +125              | °C   |

6. The R<sub>θJA</sub> is dependent on the PCB heat dissipation. Board used to drive this data was a 2s2p JEDEC PCB standard. Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.

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**Table 4. ELECTRICAL CHARACTERISTICS** Min & Max Limits apply for  $T_A$  between  $-20^{\circ}\text{C}$  to  $+85^{\circ}\text{C}$  and  $T_J$  up to  $+125^{\circ}\text{C}$  for  $V_{IN}$  between 4.5 V to 22 V (Unless otherwise noted). Typical values are referenced to  $T_A = +25^{\circ}\text{C}$  and  $V_{IN} = 12\text{ V}$  (Unless otherwise noted).

| Symbol                     | Parameter                                | Conditions                                                    | Min                 | Typ  | Max                                       | Unit  |       |
|----------------------------|------------------------------------------|---------------------------------------------------------------|---------------------|------|-------------------------------------------|-------|-------|
| INPUT VOLTAGE              |                                          |                                                               |                     |      |                                           |       |       |
| V <sub>INDET</sub>         | Presence input detection threshold       | V <sub>IN</sub> rising                                        | 3.2                 | 3.5  | 3.8                                       | V     |       |
|                            |                                          | Hysteresis                                                    |                     | 175  |                                           | mV    |       |
| V <sub>INSYS</sub>         | Charger mode detection threshold voltage | V <sub>IN</sub> – V <sub>BCSP</sub> , V <sub>IN</sub> rising  | 95                  | 150  | 200                                       | mV    |       |
|                            |                                          | V <sub>IN</sub> – V <sub>BCSP</sub> , V <sub>IN</sub> falling | 10                  | 50   | 90                                        | mV    |       |
| V <sub>INLO</sub>          |                                          | V <sub>SEL</sub> rising                                       | 1.188               | 1.2  | 1.212                                     | V     |       |
|                            |                                          | Hysteresis                                                    | 25                  | 50   | 75                                        | mV    |       |
| V <sub>CELL</sub>          | Cells detection threshold                | V <sub>SEL</sub> rising                                       | 0.4                 | 0.45 | 0.5                                       | V     |       |
|                            |                                          | Hysteresis                                                    |                     | 50   |                                           | mV    |       |
| V <sub>INMINOK</sub>       | Operating charger valid threshold        | V <sub>IN</sub> rising, Ratio of V <sub>SYSMIN</sub>          | 103.4               | 106  | 108.6                                     | %     |       |
|                            |                                          | Hysteresis                                                    | 101.4               | 104  | 106.6                                     | %     |       |
| V <sub>INOV</sub>          | Valid input high threshold               | V <sub>IN</sub> rising (Note 7)                               | 22                  | 22.5 | 23                                        | V     |       |
|                            |                                          | Hysteresis                                                    |                     | 125  |                                           | mV    |       |
| T <sub>VINOV</sub>         | Max Hot Plug Rise time                   | ACFET present, from 0 to 30 V, no overvoltage on ACSP         |                     | 10   |                                           | V/μs  |       |
|                            |                                          | RBFET only, from 0 to 30 V, no overvoltage on BCSP            |                     | 10   |                                           |       |       |
| INPUT CURRENT LIMITING     |                                          |                                                               |                     |      |                                           |       |       |
| I <sub>INLIM</sub>         | Input current limit                      | Input Current Limit Range, Average value.                     |                     | 128  |                                           | 8064  | mA    |
|                            |                                          | Input Current Limit Default. (Note 8)                         |                     |      | 3328                                      |       | mA    |
|                            |                                          | Input Current Granularity                                     |                     |      | 128                                       |       | mA    |
|                            |                                          | Input Current Accuracy                                        | 128 mA to 2048 mA   | –64  |                                           | +64   | mA    |
| 2048 mA to 4096 mA         | –3                                       |                                                               |                     | +3   | %                                         |       |       |
| T <sub>IIN</sub>           | Current Ramping                          |                                                               |                     |      | 128/16                                    |       | mA/μs |
| I <sub>INSHORT</sub>       | Short Circuit Detect                     | Input Current Limit ILIM                                      |                     | 10   | 11                                        | 12    | A     |
| T <sub>INSHORT</sub>       | Short Circuit Detect Delay               |                                                               |                     |      | 10                                        |       | μs    |
| BATTERY AND SYSTEM VOLTAGE |                                          |                                                               |                     |      |                                           |       |       |
| V <sub>CHG</sub>           | Output voltage range                     | Programmable                                                  |                     | 3328 |                                           | 18080 | mV    |
|                            |                                          | Default value, (Note 9)                                       |                     |      | V <sub>SYSMIN</sub> + V <sub>SYSOFF</sub> |       |       |
|                            | Voltage regulation accuracy              | Constant voltage mode, ICHG>=500 mA                           |                     | –0.5 |                                           | 0.5   | %     |
|                            | Programmable granularity                 |                                                               |                     |      | 16                                        |       | mV    |
|                            | Voltage Ramping                          |                                                               |                     |      | 64/16                                     |       | mV/μs |
| V <sub>SYSOV</sub>         | System OVP                               | VBCSP Rising                                                  | VCHG ≤ 9V           |      | 10.8                                      |       | V     |
|                            |                                          |                                                               | 9 V ≤ VCHG ≤ 13.5 V |      | 14.4                                      |       | V     |
|                            |                                          |                                                               | VCHG > 13.5 V       |      | 21.6                                      |       | V     |
|                            | SYSOV Release Threshold                  | Hysteresis, Ratio of V <sub>CHG</sub> Rising Edge             |                     |      | 102                                       |       | %     |
| V <sub>BUCKOV</sub>        | Buck Out of Regulation                   | VBCSP Rising, Ratio of V <sub>CHG</sub> Rising Edge           |                     |      | 104                                       |       | %     |
|                            | BUCKOV Release Threshold                 | Hysteresis                                                    |                     |      | 102                                       |       | %     |

7. 19 V and 14.5 V versions are available upon request

8. 2560 mA versions is available upon request

9. 5.6 V, 12.352 V and 16.592 V versions are available upon request

10. 512 mA, 1024 mA and 2048 mA versions are available upon request

11. 256 mA, 128 mA and 0 mA versions are available upon request

12. 5.6 V, 5.7 V, 5.8 V versions are available upon request

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**Table 4. ELECTRICAL CHARACTERISTICS** Min & Max Limits apply for  $T_A$  between  $-20^{\circ}\text{C}$  to  $+85^{\circ}\text{C}$  and  $T_J$  up to  $+125^{\circ}\text{C}$  for  $V_{IN}$  between 4.5 V to 22 V (Unless otherwise noted). Typical values are referenced to  $T_A = +25^{\circ}\text{C}$  and  $V_{IN} = 12\text{ V}$  (Unless otherwise noted).

| Symbol                                | Parameter                                 | Conditions                                                 | Min  | Typ    | Max   | Unit  |
|---------------------------------------|-------------------------------------------|------------------------------------------------------------|------|--------|-------|-------|
| BATTERY AND SYSTEM VOLTAGE            |                                           |                                                            |      |        |       |       |
| V <sub>SYSMIN</sub>                   | Minimum System Voltage Range              |                                                            | 3328 |        | 17792 | mV    |
|                                       | Minimum System Voltage Default            | RCELL = 0 Ω (2–3 cells)                                    |      | 7936   |       | mV    |
|                                       |                                           | RCELL = 220 kΩ (3–4 cells)                                 |      | 12032  |       | mV    |
|                                       |                                           | Hysteresis                                                 |      | 50     |       | mV    |
|                                       | Minimum System Voltage Granularity        |                                                            |      | 128    |       | mV    |
| V <sub>SYSOFF</sub>                   | System Voltage Regulation Offset          | SYSOFF_SEL = 0, Default                                    |      | 384    |       | mV    |
|                                       |                                           | SYSOFF_SEL = 1                                             |      | 256    |       | mV    |
| CHARGE CURRENT                        |                                           |                                                            |      |        |       |       |
| I <sub>CHG</sub>                      | Charge current range                      | Programmable                                               | 128  |        | 8064  | mA    |
|                                       |                                           | Default value, (Note 10)                                   |      | 128    |       | mA    |
|                                       | Charge current accuracy                   | 128 mA to 2048 mA                                          | –64  |        | +64   | mA    |
|                                       |                                           | 2048 mA to 8064 mA                                         | –3   |        | 3     | %     |
|                                       | I <sup>2</sup> C Programmable granularity |                                                            |      | 128    |       | mA    |
| T <sub>ICHG</sub>                     | Current Ramping                           |                                                            |      | 128/16 |       | mA/μs |
| I <sub>EOC</sub>                      | End of Charge Current Range               |                                                            | 128  |        | 1024  | mA    |
|                                       | End of Charge Current Default             |                                                            |      | 256    |       | mA    |
|                                       | End of Charge Current Granularity         |                                                            |      | 128    |       | mA    |
|                                       | End of Charge Current Accuracy            |                                                            | –64  |        | +64   | mA    |
| REVERSE BLOCKING FET                  |                                           |                                                            |      |        |       |       |
| T <sub>RBDR</sub>                     | RBDRV Rise Time                           | 3 nC Load                                                  |      | 2      |       | ms    |
| T <sub>RBDF</sub>                     | RBDRV Fall Time                           | 10 nC Load                                                 |      | 1      |       | μs    |
| R <sub>RBDL</sub>                     | RBDRV Output High                         | Referred to ground                                         |      |        | 30    | V     |
| R <sub>RBDH</sub>                     |                                           | Referred to VIN, VIN ≥ 9 V                                 | 4.45 | 5      | 5.5   | V     |
| V <sub>RBDL</sub>                     | RBDRV Output Low                          | V <sub>IN</sub> < V <sub>ACSP</sub> , Referred to VIN      |      | 0      |       | V     |
| V <sub>RBDH</sub>                     |                                           | V <sub>IN</sub> > V <sub>ACSP</sub> , Referred to ACSP     |      | 0      |       | V     |
| VINOK PIN                             |                                           |                                                            |      |        |       |       |
| V <sub>OL</sub>                       | FLAG output low voltage                   | I <sub>VINOK</sub> = 3 mA                                  |      |        | 0.4   | V     |
| I <sub>INOKLK</sub>                   | Off-state leakage                         | V <sub>VINOK</sub> = 5 V                                   |      |        | 1     | μA    |
| BATTERY MOSFET FET and PRECHARGE MODE |                                           |                                                            |      |        |       |       |
| V <sub>PRERED</sub>                   | Precharge Current Reduction Range         | SYSOFF_SEL = 0, BCSP–V <sub>SYSMIN</sub> , IBAT(DC) = 0 A. | 49   |        | 399   | mV    |
| V <sub>PRESTOP</sub>                  | Precharge Current Reduction Range         | BCSP–V <sub>SYSMIN</sub> , IBAT(AC) = 0 A.                 | 0    |        | 128   |       |
| V <sub>DRCON</sub>                    | Battery FET Reconnect Detection Threshold | End of Charge, VBAT–BCSP                                   |      | 256    |       | mV    |
| V <sub>DOPEN</sub>                    | Battery FET Re–open Detection Threshold   | Supplement, VBAT–BCSP                                      | –1   |        | +5    | mV    |

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**Table 4. ELECTRICAL CHARACTERISTICS** Min & Max Limits apply for T<sub>A</sub> between -20°C to +85°C and T<sub>J</sub> up to + 125°C for V<sub>IN</sub> between 4.5 V to 22 V (Unless otherwise noted). Typical values are referenced to T<sub>A</sub> = + 25°C and V<sub>IN</sub> = 12 V (Unless otherwise noted).

| Symbol | Parameter | Conditions | Min | Typ | Max | Unit |
|--------|-----------|------------|-----|-----|-----|------|
|--------|-----------|------------|-----|-----|-----|------|

## BATTERY MOSFET FET and PRECHARGE MODE

|                     |                             |                                                                                              |      |     |     |    |
|---------------------|-----------------------------|----------------------------------------------------------------------------------------------|------|-----|-----|----|
| V <sub>PRE</sub>    | Precharge voltage threshold | V <sub>BAT</sub> rising, Ratio of V <sub>SYSMIN</sub>                                        |      | 100 |     | %  |
|                     |                             | Accuracy                                                                                     | -2   |     | +2  | %  |
|                     |                             | Hysteresis                                                                                   |      | 98  |     | %  |
| I <sub>PREMAX</sub> | Precharge Current Range     |                                                                                              | 128  |     | 512 | mA |
|                     | Precharge Current Default   | Default value (Note 11)                                                                      |      | 512 |     | mA |
|                     | Precharge Current Accuracy  |                                                                                              | -64  |     | +64 | mA |
| V <sub>BFH</sub>    | BATDRV Output High          | V <sub>BAT</sub> ≥ 3.3 V, Referred to V <sub>BAT</sub>                                       | 4.5  | 5   | 8   | V  |
| V <sub>BFL</sub>    | BATDRV Output Low           | Referred to GND                                                                              | -0.3 | 0   | 0.3 | V  |
| T <sub>FBF</sub>    | BATDRV Fall Time            | From V <sub>BFH</sub> to V <sub>BFL</sub> , 10 nC Load                                       |      | 200 |     | μs |
| T <sub>FBR</sub>    | BATDRV Rise Time            | From V <sub>BFL</sub> to V <sub>BFH</sub> , 3 nC Load, From End of Charge to Supplement mode |      | 2   |     | μs |
|                     |                             | From V <sub>BFL</sub> to V <sub>BFH</sub> , 3 nC Load.                                       |      | 5   |     | ms |

## I<sup>2</sup>C/SMBus

|                     |                             |           |      |  |     |     |
|---------------------|-----------------------------|-----------|------|--|-----|-----|
| F <sub>SCL</sub>    | Bus operating frequency     |           | 10   |  | 400 | kHz |
| T <sub>I2CTO</sub>  | Bus Timeout                 |           | 25   |  | 35  | ms  |
| V <sub>I2CINT</sub> | Peak voltage at SCL line    |           | 2.7  |  | 5.5 | V   |
| V <sub>I2CIL</sub>  | SCL, SDA low input voltage  |           | -0.5 |  | 0.5 | V   |
| V <sub>I2CIH</sub>  | SCL, SDA high input voltage |           | 1.7  |  | 5.5 | V   |
| V <sub>I2COL</sub>  | SDA low output voltage      | Sink 3 mA | 0    |  | 0.4 | V   |

## BUCK CONVERTER

|                     |                                      |              |     |     |      |     |
|---------------------|--------------------------------------|--------------|-----|-----|------|-----|
| F <sub>SWCHG</sub>  | Switching Frequency Range            |              | 600 |     | 1200 | kHz |
|                     | Switching Frequency Default          |              |     | 800 |      | kHz |
|                     | Switching Frequency Granularity      |              |     | 200 |      | kHz |
|                     | Switching Frequency Accuracy         |              | -10 |     | +10  | %   |
| F <sub>SWSMB</sub>  | Spread Spectrum Modulation Bandwidth | Ratio of FSW |     | 6   |      | %   |
| F <sub>SWSMR</sub>  | Spread Spectrum Modulation Rate      |              |     | 23  |      | kHz |
| I <sub>OUTMAX</sub> | Output Current Capability            |              | 8   |     |      | A   |
| I <sub>PKMAX</sub>  | Maximum peak inductor current        |              |     | 9   |      | A   |

## GENERAL PARAMETERS

|                   |                                                    |                                                                                                       |  |  |      |    |
|-------------------|----------------------------------------------------|-------------------------------------------------------------------------------------------------------|--|--|------|----|
| I <sub>OFF</sub>  | OFF Mode quiescent current (Measured on BAT)       | PMO_EN = 0, VDROOP_EN = 0, VIN = 0 V, 2~3 Cells                                                       |  |  | 10   | μA |
|                   |                                                    | PMO_EN = 0, VDROOP_EN = 0, VIN = 0 V, 4 Cells                                                         |  |  | 12   |    |
| I <sub>QLB</sub>  | Drop Detection Quiescent Current (Measured on BAT) | OFF mode. PMO_EN = 0, VDROOP_EN = 1 VIN = 0 V, VBAT > V <sub>LOBAT</sub> , VDRP_SEL ! = 00, 2~3 Cells |  |  | 80   | μA |
|                   |                                                    | OFF mode. PMO_EN = 0, VDROOP_EN = 1 VIN = 0V, VBAT > V <sub>LOBAT</sub> , VDRP_SEL ! = 00, 4 Cells    |  |  | 140  |    |
| I <sub>STBY</sub> | PMO block quiescent current (Measured on BAT)      | OFF mode. PMO_EN = 1, VDROOP_EN = 0 VIN = 0 V, VBAT > 4 V                                             |  |  | 1500 | μA |

7. 19 V and 14.5 V versions are available upon request
8. 2560 mA versions is available upon request
9. 5.6 V, 12.352 V and 16.592 V versions are available upon request
10. 512 mA, 1024 mA and 2048 mA versions are available upon request
11. 256 mA, 128 mA and 0 mA versions are available upon request
12. 5.6 V, 5.7 V, 5.8 V versions are available upon request

# NCP1871

**Table 4. ELECTRICAL CHARACTERISTICS** Min & Max Limits apply for T<sub>A</sub> between -20°C to +85°C and T<sub>J</sub> up to + 125°C for V<sub>IN</sub> between 4.5 V to 22 V (Unless otherwise noted). Typical values are referenced to T<sub>A</sub> = + 25°C and V<sub>IN</sub> = 12 V (Unless otherwise noted).

| Symbol                              | Parameter                              | Conditions                                                                                                                                 | Min  | Typ   | Max  | Unit              |
|-------------------------------------|----------------------------------------|--------------------------------------------------------------------------------------------------------------------------------------------|------|-------|------|-------------------|
| <b>GENERAL PARAMETERS</b>           |                                        |                                                                                                                                            |      |       |      |                   |
| E <sub>ECO</sub>                    | NCP1871 Efficiency                     | With Recommended operating condition, V <sub>IN</sub> = 12 V, V <sub>BAT</sub> = 8.4 V, PMO_EN = 0, VDROOP_EN = 0 ECO_MODE = 1, 20 mA load |      | 80    |      | %                 |
| V <sub>CORE</sub>                   | Core supply voltage                    | V <sub>IN</sub> > 5.5 V                                                                                                                    |      | 5     |      | V                 |
| V <sub>UVLO</sub>                   | System UVLO                            | V <sub>IN</sub> or V <sub>BAT</sub> rising, SMBus register available                                                                       |      |       | 4    | V                 |
| T <sub>SD</sub>                     | Thermal Shutdown                       |                                                                                                                                            |      | 135   |      | °C                |
| <b>CURRENT AND POWER MONITORING</b> |                                        |                                                                                                                                            |      |       |      |                   |
| G <sub>BC</sub>                     | Battery Current Sense Gain             | GBC_SEL = 0, Default                                                                                                                       |      | 0.2   |      | μA/mV             |
|                                     |                                        | GBC_SEL = 1                                                                                                                                |      | 0.4   |      | μA/mV             |
| A <sub>BC</sub>                     | Battery Voltage Sense Scaling          |                                                                                                                                            |      | 2     |      | μA/V              |
| G <sub>AC</sub>                     | Adapter Current Sense Gain             |                                                                                                                                            |      | 0.2   |      | μA/mV             |
| A <sub>AC</sub>                     | Adapter Voltage Sense Scaling          |                                                                                                                                            |      | 2     |      | μA/V              |
| K <sub>AC</sub> , K <sub>BC</sub>   | Mixer Gain                             | GAIN_SEL = 0, Default                                                                                                                      |      | 250   |      | kA/A <sup>2</sup> |
|                                     |                                        | GAIN_SEL = 1                                                                                                                               |      | 500   |      | kA/A <sup>2</sup> |
| I <sub>PMO</sub>                    | Power Monitor Output Current           | Full Scale                                                                                                                                 |      | 100   |      | μA                |
| I <sub>PAC</sub> , I <sub>PBC</sub> | Power Monitor Accuracy per channel     | 1.00x Full Scale                                                                                                                           | -5   |       | 5    | %                 |
|                                     |                                        | 0.10x Full Scale                                                                                                                           | -8.5 |       | 8.5  | %                 |
|                                     |                                        | 0.03x Full Scale                                                                                                                           | -20  |       | 20   | %                 |
| F <sub>PMO</sub>                    | Power Monitor Bandwidth                |                                                                                                                                            |      | 8     |      | kHz               |
| V <sub>DRPREF</sub>                 | VDRP Fast Comparator Reference Voltage | DRP_SEL = 00, Relative to V <sub>SYSMIN</sub>                                                                                              |      | 97    |      | %                 |
|                                     |                                        | DRP_SEL = 01                                                                                                                               |      | 5.6   |      | V                 |
|                                     |                                        | DRP_SEL = 10, Default                                                                                                                      |      | 5.8   |      | V                 |
|                                     |                                        | DRP_SEL = 11                                                                                                                               |      | 6     |      | V                 |
|                                     | VDRP Fast Comparator Accuracy          |                                                                                                                                            | -2.1 |       | +2.1 | %                 |
|                                     | VDRP Fast Comparator Debounce          |                                                                                                                                            |      | 2     |      | μs                |
| V <sub>LOBAT</sub>                  | VDRP Slow Comparator Detection Level   | VLOBAT_REG = 00, Ratio of VDRPREF                                                                                                          |      | OFF   |      | %                 |
|                                     |                                        | VLOBAT_REG = 01                                                                                                                            |      | 105   |      |                   |
|                                     |                                        | VLOBAT_REG = 10, Default                                                                                                                   |      | 107.5 |      |                   |
|                                     |                                        | VLOBAT_REG = 11                                                                                                                            |      | 110   |      |                   |
| T <sub>LBDEB</sub>                  | VDRP Slow Comparator Debounce          |                                                                                                                                            |      | 128   |      | ms                |
| I <sub>LBSK</sub>                   | PRHOTB Sink Capability                 | Output 0.4 V                                                                                                                               | 40   |       |      | mA                |
| T <sub>LBPS</sub>                   | Pulse Stretch Duration                 |                                                                                                                                            |      | 10    |      | ms                |
| V <sub>BAT_RMV</sub>                | Battery Removal Detection Threshold    | BATRMV_SEL = 0, Default                                                                                                                    | 2.7  | 2.85  | 3    | V                 |
|                                     |                                        | BATRMV_SEL = 1                                                                                                                             | 1.5  | 1.6   | 1.7  |                   |
|                                     | Battery Removal Detection time         |                                                                                                                                            |      | 4     |      | μs                |
| I <sub>BAT_RMV</sub>                | TS Input Leakage                       |                                                                                                                                            |      |       | 100  | nA                |

7. 19 V and 14.5 V versions are available upon request
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11. 256 mA, 128 mA and 0 mA versions are available upon request
12. 5.6 V, 5.7 V, 5.8 V versions are available upon request

# Charging Process

INCHG\_OK = (INOK and not VINOK\_SEL) or (INMINOK and VINOK\_SEL)

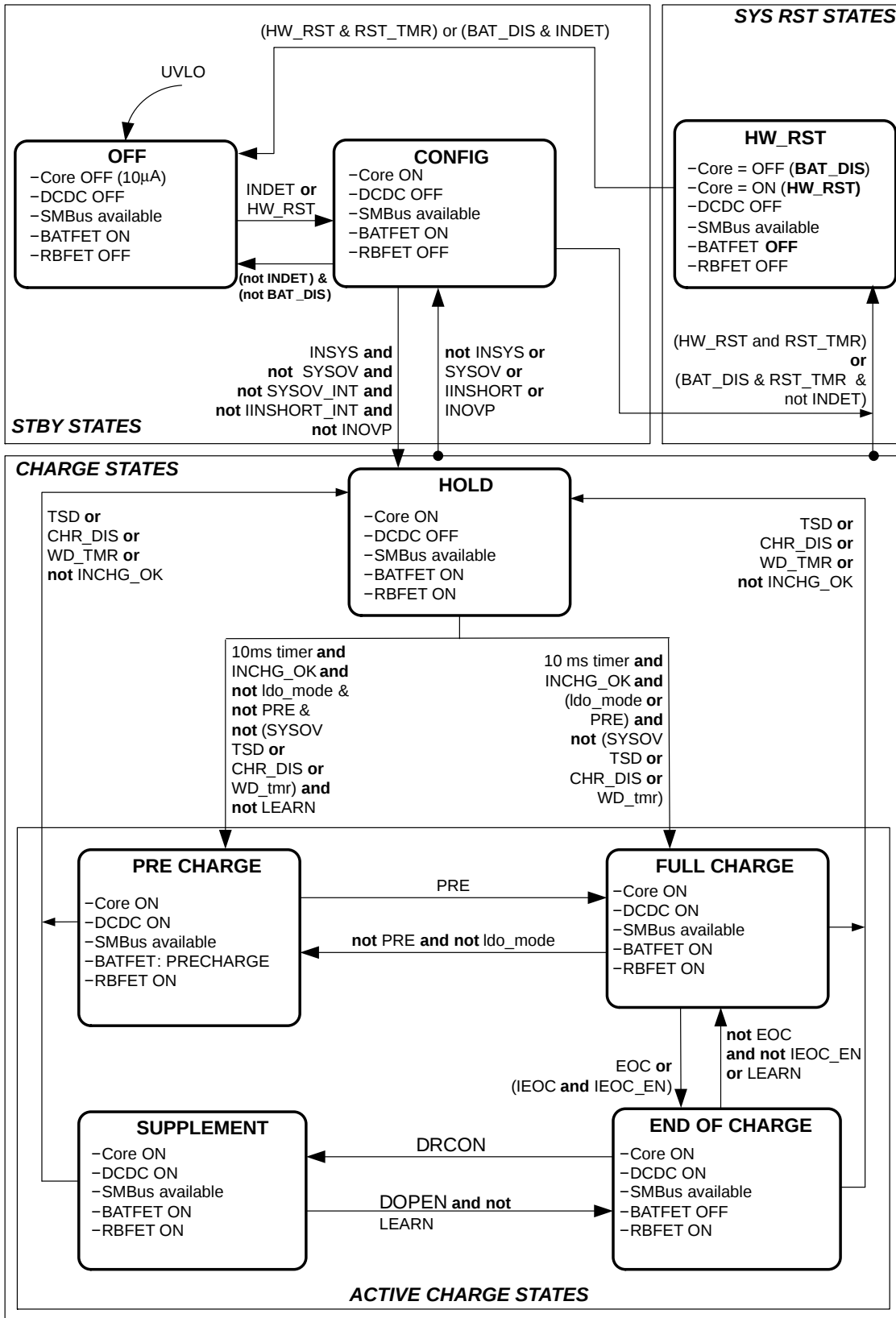


Figure 3. Charging State Machine

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## Block Diagram

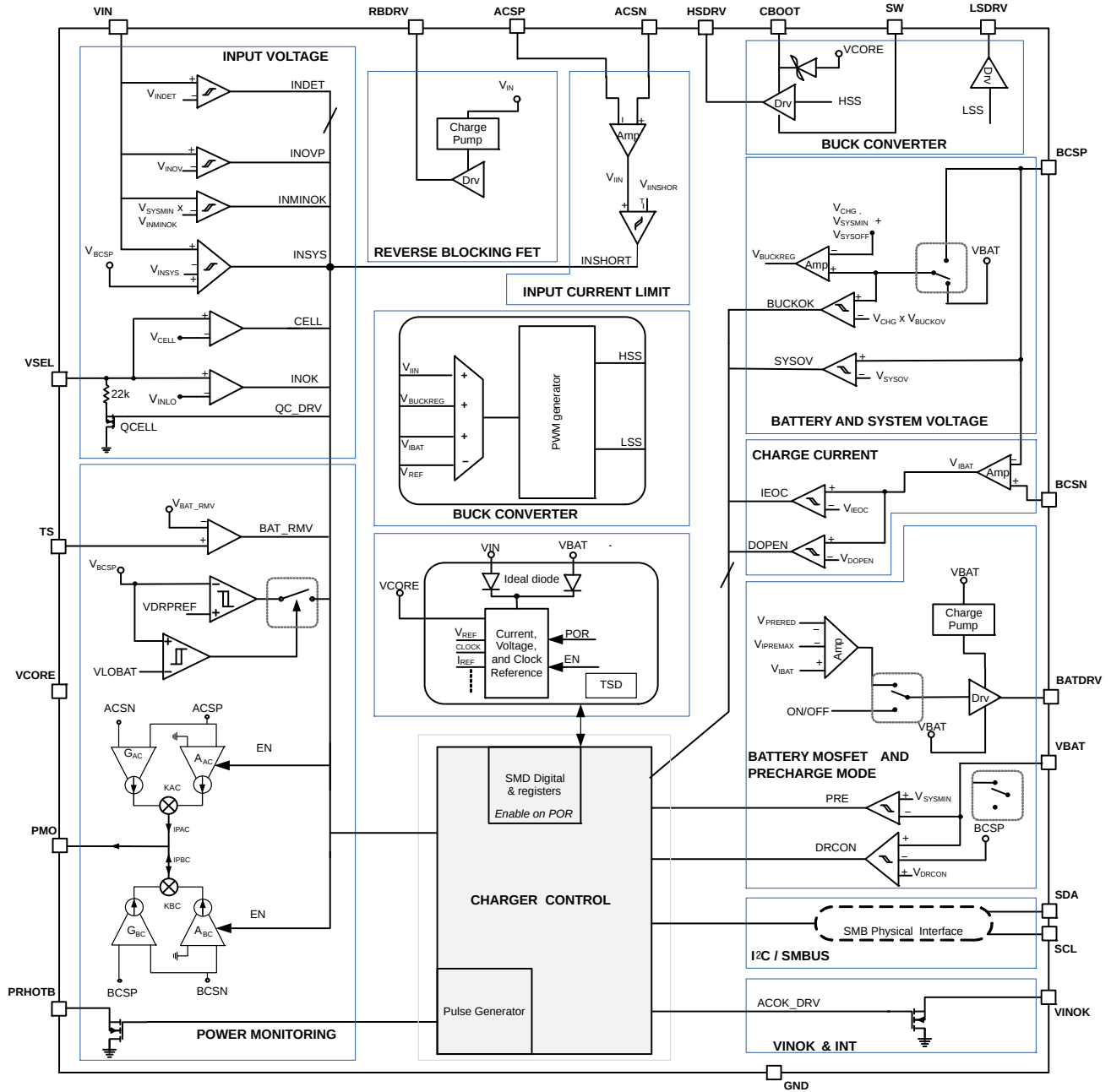


Figure 4. Detailed Block Diagram

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## SMBUS Registers Map

SMBUS slave address (binary): b0001001x.

| ChargeOption Register – Memory Location : 12h |      |             |               |           |                                                                                              |
|-----------------------------------------------|------|-------------|---------------|-----------|----------------------------------------------------------------------------------------------|
| Bit                                           | Type | Reset       | Name          | RST Value | Function                                                                                     |
| 0                                             | RW   | POR, TR_OFF | CHR_DIS       | 0         | Charge is suspend when set 1                                                                 |
| 1                                             | RW   | POR, TR_OFF | EOC           | 0         | Set 1 will jump to End of Charge state from FULL charge: signal dictated by the Fuel Gauge   |
| 2                                             | RW   | POR, TR_OFF | IEOC_EN       | 0         | Set 1 enable the charger end of charge detection                                             |
| 3                                             | RW   | POR, TR_OFF | LEARN         | 0         | Set 1 enable the LEARN mode                                                                  |
| 4                                             | RW   | POR, TR_OFF | PMOBAT_EN     | 0         | Set 1 enable the Battery Power monitoring circuitry                                          |
| 5                                             | RW   | POR, TR_OFF | PMOAC_EN      | 0         | Set 1 enable the Input Power monitoring circuitry                                            |
| 6                                             | RW   | POR, TR_OFF | GAIN_SEL      | 0         | Multiplier Gain selection<br>0: Full scale 100 W<br>1: Full scale 50 W                       |
| 7                                             | RW   | POR, TR_OFF | PMO_IMO_SEL   | 0         | 0 : PMO selected<br>1: IMO selected                                                          |
| 8                                             | RW   | POR, TR_OFF | GBC_SEL       | 0         | 0: Battery Current Sense Gain is 10<br>1: Battery Current Sense Gain is 20                   |
| 9                                             | RW   | POR, TR_OFF | WDTMR_SET[0]  | 1         | Watchdog timer [1:0]:<br>00: Disable<br>01: 32s<br>10: 64s<br>11: 128s                       |
| 10                                            | RW   | POR, TR_OFF | WDTMR_SET[1]  | 0         |                                                                                              |
| 11                                            | RW   | POR, TR_OFF | FREQ_SEL[0]   | 01        | DCDC frequency selection[1:0]:<br>00: 600 kHz<br>01: 800 kHz<br>10: 1000 kHz<br>11: 1200 kHz |
| 12                                            | RW   | POR, TR_OFF | FREQ_SEL[1]   |           |                                                                                              |
| 13                                            | RW   | POR, TR_OFF | VLOBAT_REG[0] | 0         | Ratio of VDRPREF[1:0]:<br>00: Off<br>01: 105%<br>10: 107.5%<br>11: 110%                      |
| 14                                            | RW   | POR, TR_OFF | VLOBAT_REG[1] | 1         |                                                                                              |
| 15                                            | RW   | POR, TR_OFF | VDROOP_EN     | 0         | 0: Critical Voltage Monitoring disable<br>1: Critical Voltage Monitoring enable              |

| ChargeCurrent Register – Memory Location : 14h |      |             |        |           |                                                                                  |
|------------------------------------------------|------|-------------|--------|-----------|----------------------------------------------------------------------------------|
| Bit                                            | Type | Reset       | Name   | RST Value | Function                                                                         |
| 0                                              | RW   | POR, TR_OFF | IPRE_0 | 11        | 00: 0 mA<br>01: 128 mA<br>10: 256 mA<br>11: 512 mA                               |
| 1                                              | RW   | POR, TR_OFF | IPRE_1 |           |                                                                                  |
| 2                                              | R    |             |        |           | Not Used                                                                         |
| 3                                              | R    |             |        |           | Not Used                                                                         |
| 4                                              | R    |             |        |           | Not Used                                                                         |
| 5                                              | R    |             |        |           | Not Used                                                                         |
| 6                                              | R    |             |        |           | Not Used                                                                         |
| 7                                              | RW   | POR, TR_OFF | ICHG_0 | 000001    | 000001 : 128 mA (Lower Clamp)<br>111111: 8064 mA (Higher Clamp)<br>Step : 128 mA |
| 8                                              | RW   | POR, TR_OFF | ICHG_1 |           |                                                                                  |
| 9                                              | RW   | POR, TR_OFF | ICHG_2 |           |                                                                                  |
| 10                                             | RW   | POR, TR_OFF | ICHG_3 |           |                                                                                  |
| 11                                             | RW   | POR, TR_OFF | ICHG_4 |           |                                                                                  |
| 12                                             | RW   | POR, TR_OFF | ICHG_5 |           |                                                                                  |
| 13                                             | R    |             |        |           | Not Used                                                                         |
| 14                                             | R    |             |        |           | Not Used                                                                         |
| 15                                             | R    |             |        |           | Not Used                                                                         |

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| ChargeVoltage Register – Memory Location : 15h |      |             |         |                      |                                                                                                                                               |
|------------------------------------------------|------|-------------|---------|----------------------|-----------------------------------------------------------------------------------------------------------------------------------------------|
| Bit                                            | Type | Reset       | Name    | RST Value            | Function                                                                                                                                      |
| 0                                              | R    |             |         |                      | Not Used                                                                                                                                      |
| 1                                              | R    |             |         |                      | Not Used                                                                                                                                      |
| 2                                              | R    |             |         |                      | Not Used                                                                                                                                      |
| 3                                              | R    |             |         |                      | Not Used                                                                                                                                      |
| 4                                              | RW   | POR, TR_OFF | VCHG_0  | VSYSMIN +<br>VSYSOFF | 0000000000 : 3.328 V<br>00011010000 : 3.328 V (Lower Clamp)<br>10001101010 : 18.080 V (Higher Clamp)<br>1111111111 : 18.080 V<br>Step : 16 mV |
| 5                                              | RW   | POR, TR_OFF | VCHG_1  |                      |                                                                                                                                               |
| 6                                              | RW   | POR, TR_OFF | VCHG_2  |                      |                                                                                                                                               |
| 7                                              | RW   | POR, TR_OFF | VCHG_3  |                      |                                                                                                                                               |
| 8                                              | RW   | POR, TR_OFF | VCHG_4  |                      |                                                                                                                                               |
| 9                                              | RW   | POR, TR_OFF | VCHG_5  |                      |                                                                                                                                               |
| 10                                             | RW   | POR, TR_OFF | VCHG_6  |                      |                                                                                                                                               |
| 11                                             | RW   | POR, TR_OFF | VCHG_7  |                      |                                                                                                                                               |
| 12                                             | RW   | POR, TR_OFF | VCHG_8  |                      |                                                                                                                                               |
| 13                                             | RW   | POR, TR_OFF | VCHG_9  |                      |                                                                                                                                               |
| 14                                             | RW   | POR, TR_OFF | VCHG_10 |                      |                                                                                                                                               |
| 15                                             | R    |             |         |                      | Not Used                                                                                                                                      |

| ChargeOption2 Register – Memory Location : 3Ch |      |             |                |           |                                                                                                                                                          |
|------------------------------------------------|------|-------------|----------------|-----------|----------------------------------------------------------------------------------------------------------------------------------------------------------|
| Bit                                            | Type | Reset       | Name           | RST Value | Function                                                                                                                                                 |
| 0                                              | RW   | POR, TR_OFF | HW_RST         | 0         | Set 1 will disconnect the battery after RST_TMR                                                                                                          |
| 1                                              | RW   | POR, TR_OFF | BAT_DIS        | 0         | Set 1 disconnect the battery when IN unplug until the next IN plug                                                                                       |
| 2                                              | RW   | POR, TR_OFF | FAULT_MSK      | 0         | Set 1 Mask fault interruption                                                                                                                            |
| 3                                              | RW   | POR, TR_OFF | STATUS_MSK     | 0         | Set 1 Mask Status interruption                                                                                                                           |
| 4                                              | R    |             | STATE[0]       |           | Charge state [2:0]:<br>000: OFF<br>001: CONFIG<br>010: HOLD<br>011: PRECHARGE<br>100: FULLCHARGE<br>101: SUPPLEMENT<br>110: END OF CHARGE<br>111: HW_RST |
| 5                                              | R    |             | STATE[1]       |           |                                                                                                                                                          |
| 6                                              | R    |             | STATE[2]       |           |                                                                                                                                                          |
| 7                                              | RW   | POR, TR_OFF | RST_TMR_SET[0] | 0         | Reset Timer<br>00: 0 ms<br>01: 512 ms<br>10: 1024 ms<br>11: 2048 ms                                                                                      |
| 8                                              | RW   | POR, TR_OFF | RST_TMR_SET[1] | 1         |                                                                                                                                                          |
| 9                                              | RW   | POR, TR_OFF | FREQ_S_EN      | 0         | Frequency Spread Spectrum enable<br>0: Disable<br>1: Enable                                                                                              |
| 10                                             | RW   | POR, TR_OFF | CPEXIT_EN      | 0         | 0: CP exit disable<br>1: CP exit Enable                                                                                                                  |
| 11                                             | RW   | POR, TR_OFF | IEOC[0]        | 1         | 000: 128 mA<br>001: 256 mA<br>010: 384 mA<br>011: 512 mA<br>100: 640 mA<br>101: 768 mA<br>110: 896 mA<br>111: 1024 mA                                    |
| 12                                             | RW   | POR, TR_OFF | IEOC[1]        | 0         |                                                                                                                                                          |
| 13                                             | RW   | POR, TR_OFF | IEOC[2]        | 0         |                                                                                                                                                          |
| 14                                             | RW   | POR, TR_OFF | LDO_MODE       | 0         | Set 1 select LDO mode                                                                                                                                    |
| 15                                             | RW   | POR, TR_OFF | ECO_MODE       | 1         | 0: No Eco Mode<br>1: Eco Mode                                                                                                                            |

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| Interrupt Register – Memory Location : 3Dh |      |          |              |           |                                     |
|--------------------------------------------|------|----------|--------------|-----------|-------------------------------------|
| Bit                                        | Type | Reset    | Name         | RST Value | Function                            |
| 0                                          | RC   | POR, OFF | EOC_INT      | 0         | Flag End of Charge State is reached |
| 1                                          | RC   | POR, OFF | PRE_INT      | 0         | Flag Precharge state is reached     |
| 2                                          | RC   | POR, OFF | LEARNB_INT   | 0         | Flag entering/exiting Learn mode    |
| 3                                          | RC   | POR, OFF | WDOG_INT     | 0         | Flag a WatchDog Timer expired       |
| 4                                          | RC   | POR, OFF | IPEAK_INT    | 0         | Flag IPEAK MAX is reached           |
| 5                                          | RC   | POR, OFF | INOVP_INT    | 0         | Flag VIN> VINOV                     |
| 6                                          | RC   | POR, OFF | BUCK_OVP_INT | 0         | Flag BUCK OV                        |
| 7                                          | R    | POR, OFF | IINSHORT_INT | 0         | Flag IIN> IINSHORT                  |
| 8                                          | RC   | POR      | HW_RST_INT   | 0         | Flag HW_RST state and HW_RST=1      |
| 9                                          | RC   | POR      | BAT_DIS_INT  | 0         | Flag HW_RST state and BAT_DIS=1     |
| 10                                         | W1C  | POR, OFF | SYSOV_INT    | 0         | Flag System Overvoltage             |
| 11                                         | RC   | POR, OFF | BAT_RMV_INT  | 0         | Flag battery is removed             |
| 12                                         | R    |          |              |           | Not Used                            |
| 13                                         | R    |          |              |           | Not Used                            |
| 14                                         | R    |          |              |           | Not Used                            |
| 15                                         | R    |          |              |           | Not Used                            |

| MinSysVoltage Register – Memory Location : 3Eh |      |             |            |                                |                                                                                                                                      |
|------------------------------------------------|------|-------------|------------|--------------------------------|--------------------------------------------------------------------------------------------------------------------------------------|
| Bit                                            | Type | Reset       | Name       | RST Value                      | Function                                                                                                                             |
| 0                                              | RW   | POR, TR_OFF | VDYNPRE_EN | 1                              | 0: Dynamic precharge disable<br>1: Dynamic precharge enable                                                                          |
| 1                                              | RW   | POR, TR_OFF | VINOK_SEL  | 0                              | Control VINOK signal<br>0: INOK is set by VSEL<br>1 INOK is set by VSYSMIN                                                           |
| 2                                              | R    |             |            |                                | Not Used                                                                                                                             |
| 3                                              | R    |             |            |                                | Not Used                                                                                                                             |
| 4                                              | R    |             |            |                                | Not Used                                                                                                                             |
| 5                                              | R    |             |            |                                | Not Used                                                                                                                             |
| 6                                              | R    |             |            |                                | Not Used                                                                                                                             |
| 7                                              | RW   | POR, TR_OFF | VSYSMIN_0  | See electrical characteristics | 00000000 : 3.328 V<br>00011010 : 3.328 V (Lower Clamp)<br>10001011 : 17.792 V (Higher Clamp)<br>11111111 : 17.792 V<br>Step : 128 mV |
| 8                                              | RW   | POR, TR_OFF | VSYSMIN_1  |                                |                                                                                                                                      |
| 9                                              | RW   | POR, TR_OFF | VSYSMIN_2  |                                |                                                                                                                                      |
| 10                                             | RW   | POR, TR_OFF | VSYSMIN_3  |                                |                                                                                                                                      |
| 11                                             | RW   | POR, TR_OFF | VSYSMIN_4  |                                |                                                                                                                                      |
| 12                                             | RW   | POR, TR_OFF | VSYSMIN_5  |                                |                                                                                                                                      |
| 13                                             | RW   | POR, TR_OFF | VSYSMIN_6  |                                |                                                                                                                                      |
| 14                                             | RW   | POR, TR_OFF | VSYSMIN_7  |                                |                                                                                                                                      |
| 15                                             | RW   | POR, TR_OFF | N_CELL_EN  | 1                              | 0: VSYSMIN default value detection disable<br>1: VSYSMIN default value detection enable                                              |

## Reset Legend:

- OFF: Set bit to RST VALUE when the charging state machine is in OFF state.
- TR\_OFF: Set bit to RST VALUE when the charging state machine transits to OFF state.
- POR: Set bit to RST VALUE on power on reset.
- W1C : Need to write 1 to reset this bit to 0
- RC : Read this bit to reset to 0

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| InputCurrent Register – Memory Location : 3Fh |      |             |          |           |                                                                                      |
|-----------------------------------------------|------|-------------|----------|-----------|--------------------------------------------------------------------------------------|
| Bit                                           | Type | Reset       | Name     | RST Value | Function                                                                             |
| 0                                             | R    |             |          |           | Not Used                                                                             |
| 1                                             | R    |             |          |           | Not Used                                                                             |
| 2                                             | R    |             |          |           | Not Used                                                                             |
| 3                                             | R    |             |          |           | Not Used                                                                             |
| 4                                             | R    |             |          |           | Not Used                                                                             |
| 5                                             | R    |             |          |           | Not Used                                                                             |
| 6                                             | R    |             |          |           | Not Used                                                                             |
| 7                                             | RW   | POR, TR_OFF | IINLIM_0 | 011010    | 000000: 128 mA<br>000001 : 128 mA (Lower Clamp)<br>111111 : 8064 mA<br>Step : 128 mA |
| 8                                             | RW   | POR, TR_OFF | IINLIM_1 |           |                                                                                      |
| 9                                             | RW   | POR, TR_OFF | IINLIM_2 |           |                                                                                      |
| 10                                            | RW   | POR, TR_OFF | IINLIM_3 |           |                                                                                      |
| 11                                            | RW   | POR, TR_OFF | IINLIM_4 |           |                                                                                      |
| 12                                            | RW   | POR, TR_OFF | IINLIM_5 |           |                                                                                      |
| 13                                            | R    |             |          |           | Not Used                                                                             |
| 14                                            | R    |             |          |           | Not Used                                                                             |
| 15                                            | R    |             |          |           | Not Used                                                                             |

| ChargeOption3 Register – Memory Location : 40h |      |             |            |           |                                                                                                                 |
|------------------------------------------------|------|-------------|------------|-----------|-----------------------------------------------------------------------------------------------------------------|
| Bit                                            | Type | Reset       | Name       | RST Value | Function                                                                                                        |
| 0                                              | RW   | POR, TR_OFF | SYSOFF_SEL | 0         | VSYS offset selection:<br>0 : 384 mV<br>1 : 256 mV                                                              |
| 1                                              | RW   | POR, TR_OFF | DRP_SEL[0] | 10        | VDROOP threshold selection:<br>00 : 97% Relative to V <sub>SYSMIN</sub><br>01 : 5.6 V<br>10 : 5.8 V<br>11 : 6 V |
| 2                                              | RW   | POR, TR_OFF | DRP_SEL[1] |           |                                                                                                                 |
| 3                                              | RW   | POR, TR_OFF | BATRMV_SEL | 0         | Battery removal threshold selection:<br>0 : 2.85 V<br>1 : 1.6 V                                                 |
| 4                                              | R    |             |            |           | Not Used                                                                                                        |
| 5                                              | R    |             |            |           | Not Used                                                                                                        |
| 6                                              | R    |             |            |           | Not Used                                                                                                        |
| 7                                              | R    |             |            |           | Not Used                                                                                                        |
| 8                                              | R    |             |            |           | Not Used                                                                                                        |
| 9                                              | R    |             |            |           | Not Used                                                                                                        |
| 10                                             | R    |             |            |           | Not Used                                                                                                        |
| 11                                             | R    |             |            |           | Not Used                                                                                                        |
| 12                                             | R    |             |            |           | Not Used                                                                                                        |
| 13                                             | R    |             |            |           | Not Used                                                                                                        |
| 14                                             | R    |             |            |           | Not Used                                                                                                        |
| 15                                             | R    |             |            |           | Not Used                                                                                                        |

# NCP1871

| ManufacturerID Register – Memory Location : FEh |      |       |              |           |          |
|-------------------------------------------------|------|-------|--------------|-----------|----------|
| Bit                                             | Type | Reset | Name         | RST Value | Function |
| 0                                               | R    |       | MAN_ID[15:0] | 0         |          |
| 1                                               | R    |       |              | 0         |          |
| 2                                               | R    |       |              | 0         |          |
| 3                                               | R    |       |              | 0         |          |
| 4                                               | R    |       |              | 0         |          |
| 5                                               | R    |       |              | 0         |          |
| 6                                               | R    |       |              | 0         |          |
| 7                                               | R    |       |              | 0         |          |
| 8                                               | R    |       |              | 0         |          |
| 9                                               | R    |       |              | 0         |          |
| 10                                              | R    |       |              | 0         |          |
| 11                                              | R    |       |              | 0         |          |
| 12                                              | R    |       |              | 0         |          |
| 13                                              | R    |       |              | 1         |          |
| 14                                              | R    |       |              | 1         |          |
| 15                                              | R    |       |              | 1         |          |

| DeviceID Register – Memory Location : FFh |      |       |              |           |          |
|-------------------------------------------|------|-------|--------------|-----------|----------|
| Bit                                       | Type | Reset | Name         | RST Value | Function |
| 0                                         | R    |       | DEV_ID[15:0] | 0         |          |
| 1                                         | R    |       |              | 0         |          |
| 2                                         | R    |       |              | 0         |          |
| 3                                         | R    |       |              | 0         |          |
| 4                                         | R    |       |              | 0         |          |
| 5                                         | R    |       |              | 0         |          |
| 6                                         | R    |       |              | 0         |          |
| 7                                         | R    |       |              | 0         |          |
| 8                                         | R    |       |              | 0         |          |
| 9                                         | R    |       |              | 0         |          |
| 10                                        | R    |       |              | 0         |          |
| 11                                        | R    |       |              | 0         |          |
| 12                                        | R    |       |              | 0         |          |
| 13                                        | R    |       |              | 1         |          |
| 14                                        | R    |       |              | 1         |          |
| 15                                        | R    |       |              | 1         |          |

## FUNCTIONAL DESCRIPTION

## Overview

The NCP1871 is part of On Semiconductor's growing switching battery charger family for wireless and mobile computing. The NCP1871 is a NVDC switching battery charger with characteristics that makes it perfectly suited for 2-stacked battery cell applications such as ultrabooks or tablets.

The NCP1871 is designed around a full NMOS DC to DC controller that brings down the high voltage charger adapter voltage to a regulated system supply that is in the same range as the battery pack voltage. This limits the variation on the

system supply voltage, hence the name Narrow Voltage DC (NVDC), and improves efficiency of the core converters. The device includes a voltage droop monitor, charger adapter validation and blocking as well as an intelligent battery connection control. The adapter current, charge current and system current are closely monitored and an image is provided to the host. The NCP1871 is fully programmable through an I<sup>2</sup>C compatible SMBus interface.

In below figure, the block diagram of the NCP1871 in its typical application is shown.

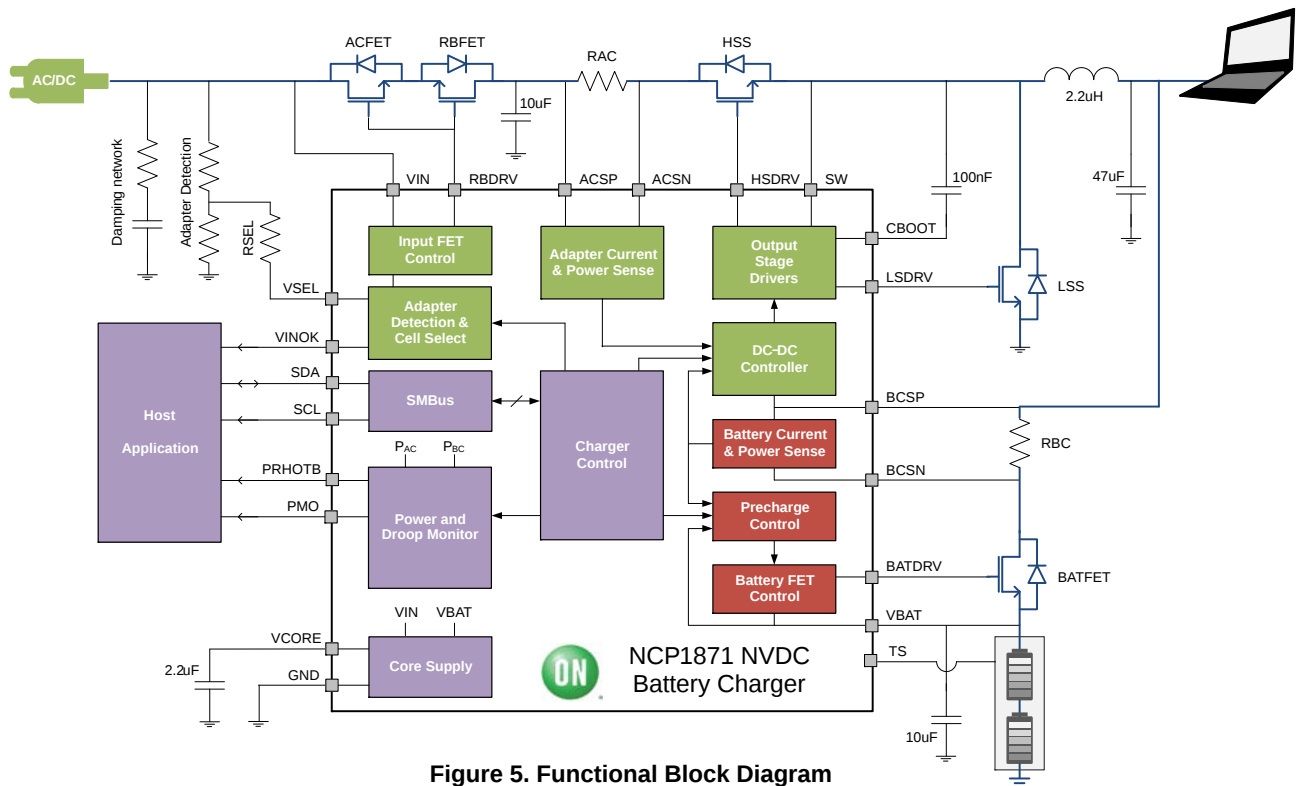


Figure 5. Functional Block Diagram

The charger adapter is connected to the application through a reverse blocking FET that avoids the leakage from the battery to input. The FET is made conducting when a valid charger is detected. At the same time a signal is generated to inform the host. Overvoltage detection will reject high voltage charge sources while protecting the application by blocking the high side FET of the DC to DC converter.

The adapter current is measured by means of a low impedance sense resistor. This information is used by the DC to DC converter to limit the average input current. Optionally, a second FET can be placed back-to-back in series with the reverse blocking FET to provide additional isolation towards the application.

The DC to DC converter supplies both the application and charges the battery pack. It regulates its output voltage, the

input current as well as the battery charge current. The latter is measured by means of a low impedance sense resistor.

The battery pack is connected to the system through a low impedance NMOS. This battery FET is opened in case the battery is depleted while the DC to DC directly supplies the application using the system voltage as its feedback.

When charging, the battery FET is closed and the charge current is monitored. The battery voltage is used as the feedback voltage for the DC to DC.

When the battery is fully charged to End of Charge state, the battery FET is opened to preserve its charge but will assist the system in case it draws more peak power than the charge adapter can deliver.

The DC to DC converter runs in fixed frequency PWM mode with pulse skipping capabilities. To reduce EMI issues, the switching frequency is selectable and a frequency

spreading feature can be enabled which can reduce peak amplitude of the EMI energy by 10 dB. Soft start of both output voltage and output current moderate the inrush current.

The DC to DC converter uses external NMOS switches to handle the high currents involved. the NCP1871 has the capability to deliver up to 8 A. Though optimized for 2-stacked cell battery packs the NCP1871 also supports 3 and 4-stacked cell batteries.

Additional features include a voltage drop monitor that can supervise critical system voltage, a learn mode that allows to cycle a battery pack to re-initiate the battery pack's fuel gauge, and a system power monitor providing a true analog image of the system power to the host.

The NCP1871 is controllable through a SMBus interface that is also compatible with a 400 kHz I<sup>2</sup>C control. A sideband interrupt signal informs the system of any event occurring. The bus allows reading out the device status as well as programming the different voltage and current levels and operating modes. The NCP1871 comes in a small 3.5 x 3.5 mm QFN-20 package at 0.5 mm pitch.

## CORE

The IC core is supplied from a locally generated VCORE. The VCORE is a regulated supply that automatically takes the highest of the AC adapter input VIN and the battery connection VBAT as its input. The core includes a bandgap and generates all necessary references for the circuit. VCORE requires a bypass capacitor.

The core operates in two distinct modes: Off and Active. In Off mode only imprecise detectors are active monitoring the VIN pin and SMBus activity while keeping the battery pack connected to the system. All other circuitries are disabled. When a VIN or SMBus activity is detected, the core transitions to the active mode where the entire core is active including the precise bandgap and clocking. In active mode the different functions of the IC can be enabled such as the DCDC converter or power monitors.

The core does not operate for voltages below the under voltage lockout threshold ( $V_{UVLO}$ ) and all internal circuitry, both analog and digital, is held in reset.

Charge Profile

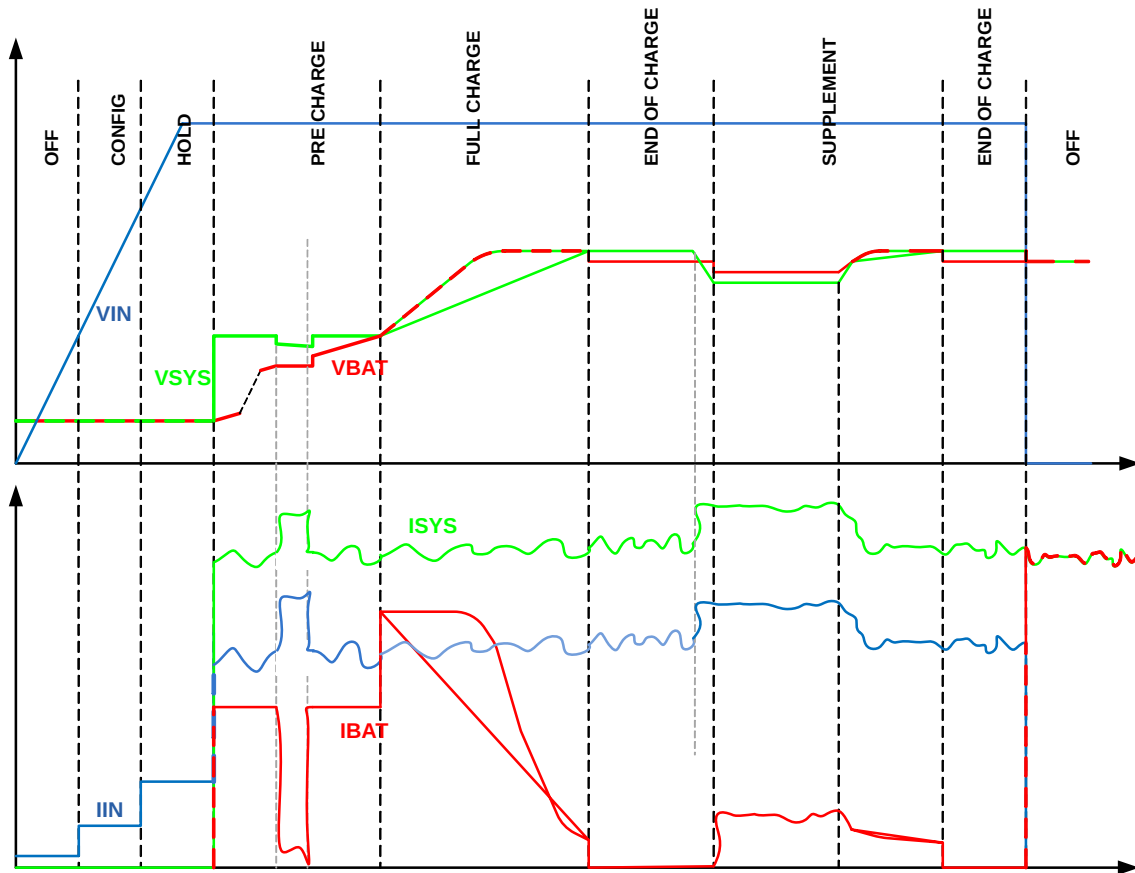


Figure 6. Typical Charge Profile

### Pre Charge

In case of a depleted battery, attaching a valid charger will enable the DC to DC and the output voltage will be raised to VCHG. The feedback of the DC to DC converter is taken from BCSP. The battery FET will be used in a linear mode to precharge the battery pack at a current IPRE. Once the battery voltage reaches the minimum system operating voltage VSYSMIN, the battery FET is slowly turned on and the feedback is now taken from VBAT. Note that VSYSMIN is to be programmed to a value lower than VCHG.

When precharging the battery, the voltage at BCSP is permanently monitored. When the output drops towards the VSYSMIN level, the precharge current is reduced to zero in an analog fashion starting with BCSP being VPRERED above the VSYSMIN level. The precharge current will drop to zero immediately if BCSP drops across VPRESTOP above the VSYSMIN level. The above described precharge behavior is the default. By opting for a LDO\_MODE option, the precharge phase will be skipped. This should only be done if the battery pack can handle a safe precharge on its own.

### Full Charge

In case of an already connected battery, attaching a valid charger will enable the DC to DC with VBAT as the feedback voltage. If at the end of the voltage ramp the VBAT is greater than VSYSMIN, the battery FET remains closed and full charging is engaged. For VBAT below the VSYSMIN however, the battery FET is automatically made non-conducting, the pin BCSP taken as the feedback, and the battery pack pre-charged as described above. By this overlapped approach the system will remain correctly supplied when opening the battery FET.

### End of Charge

Once the battery is fully charged the battery FET is made non-conducting. This avoids wear and tear of the battery cells and enhances the battery pack's lifetime. The fully charged state is determined by the battery pack's fuel gauge. Through SMBus the battery charger is then disabled. This does not mean that the DC to DC converter is disabled, just that the battery is no longer charged. Normally, it was still being charged with a small current before disabling charging for a full battery, so after the battery FET is opened, the system voltage is slightly above the battery voltage.

The end of charge detection by the charger is not the preferred method; termination by the fuel gauge is preferred at large due to the correlation between end of charge and 100% battery capacity. However, the end of charge detection may be helpful as an additional means of protection. The end of charge detection should therefore be set low. Upon an end of charge detection an interrupt is generated.

### Supplement Mode

With the FET non-conducting, the system current may exceed the power rating of the wall charger. As a result the system voltage will drop. When a significant BCSP drop of VDRCON is detected, the battery FET will be turned on and

the battery will supplement the remainder of the current to avoid further drop. Once the system current is reduced below the adapter current, the system voltage will again rise above the battery voltage and the FET is opened. The battery will not get recharged in the process as long as the charger is not re-enabled through SMBus.

### DCDC Converter

The DC to DC converter uses external NMOS pass devices for both the low side and the high side switches. To drive the gate of the high side switch at HSDRV, a bootstrap capacitor is used that is connected between SW and CBOOT. This capacitor is precharged from the VCORE reference. The gate of the low side switch is directly driven at LSDRV. Not the drain of the high side switch, but the hot side of the sense resistor should be considered as the input of the converter and therefore a capacitor has to be placed at ACSP. To avoid too high ripple in the application, the capacitor is to be grounded to the source of the low side switch before connecting to the system ground.

The output voltage of the DC to DC converter is regulated to the level VCHG as set in the ChargeVoltage register. Depending on the state of the battery FET the voltage at pin BCSP (FET open) or the voltage at pin VBAT (FET closed) is taken as the feedback voltage. The latter is done to avoid any early charge current reduction due to the IR drop between BCSP and VBAT.

Apart from the output voltage regulation, the DC to DC converter control loop will also limit the amount of input power from the AC adapter and the amount of current provided to the battery. In other words, the DC to DC converter will only be at the set output voltage if the current limits are not hit. The input current limit is set in the InputCurrent register, the charge current in the ChargeCurrent register. Note that when the input current limit is reached, the output voltage will drop automatically thus reducing the amount of current provided to the battery. In other words, priority is given to the system current over the battery charge current.

When enabled, the reference for the DC to DC output voltage is smoothly ramped. Once the output voltage ramp has finished, the charge current is ramped up. When reprogramming an established output voltage to a higher or lower value, the voltage ramp is also applied. The combination of these mechanisms limits the peak inrush current at startup and during the transitions after SMBus programming.

Once enabled, the converter operates in a fixed frequency PWM mode and will pulse skip automatically when needed. The switching frequency is selectable over a small range, it is however not advised to apply 'on the fly' changes but to use a device instance with a different default value.

During specific mode, the power consumption of the whole system is intended to be very low. An Eco mode can be enabled through I<sup>2</sup>C, (bit ECO\_MODE, register ChargeOption2) which increases the efficiency at very light load (10–20 mA).

This particular skip mode is active when the input current is lower than 100 mA. If so, the  $T_{ONMIN}$  is extended to reduce switching activity and frequency as a consequence. The buck also regulates in asynchronous mode. As soon as ECO\_MODE is set to '0' whatever the input current is, the eco mode is disabled.

The DC to DC converter switches at fairly significant current levels which could cause conducted and radiated EMI issues. A frequency spreading option can be enabled to reduce the side-effects of this. By varying the switching frequency at a constant low rate (i.e. a modulation with a triangular waveform), the peak amplitude of the EMI energy in the output spectrum can be reduced by about 10 dB. Note that the amount of power itself is not reduced, just its allocation over the frequency band.

When pulse skipping, the current in the inductor will fall to zero for each cycle (discontinuous operation). At that point both the low side and high side switches are non-conducting, and the SW node will be ringing caused by

the LC resonance created on the switch node. In absence of prolonged switching activity, the bootstrap capacitor will discharge. In order to maintain the capacitor charge, the low side FET will be turned on periodically so that the bootstrap capacitor can be recharged again to V<sub>CORE</sub> level.

To protect the DC to DC converter output transistors as well as the inductor, a peak current limiter will limit the cycle to cycle peak current. It uses the voltage drop over the input current sense resistor to monitor the peak current. A flag bit is set to inform the host about the event but the DC to DC converter is not automatically disabled.

### Current and Power Monitoring

The current and power monitoring block consists of an analog output signal reflecting the amount of power taken by the system and an open drain output signaling the host that excessive power is drawn by the system.

The below diagram depicts the power monitoring functionality.

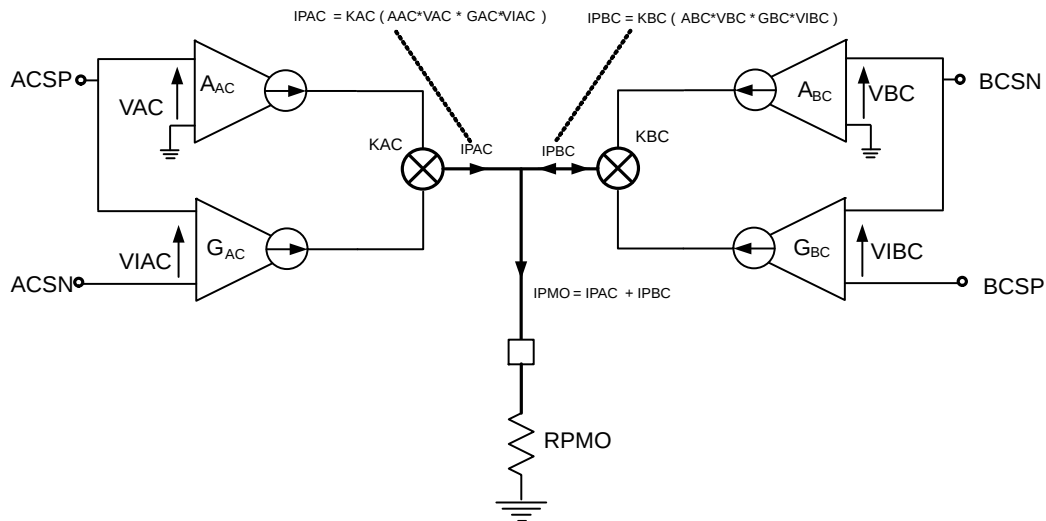


Figure 7. Power Monitoring Diagram

In order to inform the Host about the amount of power used by the system, an image of the power taken from the charger input and the battery pack is provided at the power monitor output PMO. PMO does take into account the power that is sourced to the battery during the charge cycle. Based on this information, the host can determine if it is reaching the maximum power level it is allowed to take from either source.

The adapter current is sensed through the sense resistor  $R_{AC}$  connected between the pins ACSP and ACSN. The measurement is low pass filtered to remove the current ripple due to the DC to DC activity. The resulting signal is multiplied with the adapter voltage at ACSP and amplified

to the PMO output. The current measurement signal is also used by the DC to DC converter to limit the input currents and by the adapter over current protection circuitry.

The current flowing out of and into the battery is sensed through the sense resistor  $R_{BC}$  connected between the pins BCSP and BCSN. The measurement is low pass filtered to remove any current spikes due to the transient load response of the system. The resulting signal is multiplied with the battery voltage at BCSN and amplified to the PMO output. The current measurement signal is also used by the DC to DC converter to control the charge current. The battery power sense circuitry can be enabled in both charging and non charging modes.

## VOLTAGE DROOP MONITOR

The below diagram depicts the voltage monitoring functionality.

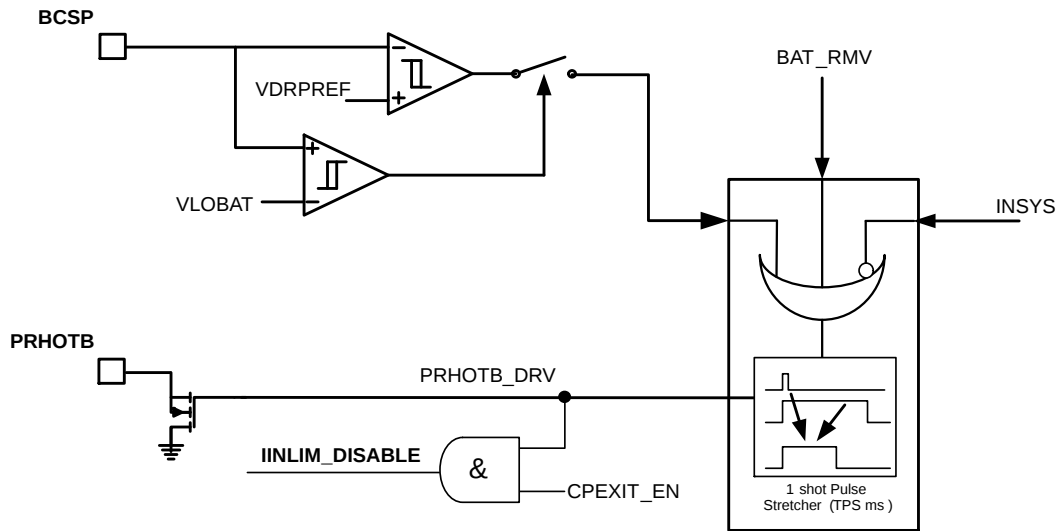


Figure 8. Critical Voltage Monitor Diagram

The critical system voltage node, is connected to BCSP and is monitored for a sudden drop due to high loading conditions. A comparator with a programmable threshold is used for this. This comparator is enable when bit VDROOP\_EN is set to 1 (register ChargeOption). For additional adjustment, the detection level can be adjusted with VDRP\_SEL bit of ChargeOption3 register. This comparator can be disabled under low battery conditions to avoid false triggering (bits VLOBAT\_REG, register ChargeOption). The overall system can be enabled in both charging and non charging modes. Note that under low battery conditions the processor peak current will be automatically reduced by the system so that critical voltage droops are avoided.

The output of the drop monitor is fed into a pulse stretcher that will ensure the PRHOTB pin will be pulled low for a guaranteed minimum period TPS which will reduce the processor speed (PROCHOT# pin) and thus the power consumed. BAT\_RMV and INSYS signal leads to a PRHOTB generation as well.

### Watchdog Timer Description

The battery charging cycle is under control of the host. It may happen that the host is too busy to survey the charger or that the system is stuck. As a safety measure therefore a watchdog timer is started after each I<sup>2</sup>C write in charge current or/and voltage setting registers during active charge states. When the watchdog timer is enabled, the charge will be suspended if IC does not receive any write charge voltage or write charge current command within the watchdog time period. This timer can be set or disabled through SMBus registers.

### Input Current Limitation

Apart from the output voltage regulation, the DC to DC converter control loop will also limit the amount of input power from the AC adapter and the amount of current provided to the battery. In other words, the DC to DC converter will only be at the set output voltage if the current limits are not hit. The input current limit is set in the InputCurrent register. Note that when the input current limit is reached, the output voltage will drop thus automatically reducing the amount of current provided to the battery.

### Battery FET

The battery pack is connected to the system voltage rail through the NMOS battery FET (BATFET), driven from BATDRV. In order to support all operating modes of the application, the battery FET can be operated in three states; fully conducting, non-conducting and linear mode.

When the application is in off mode and no charger is attached, the system voltage is maintained by the battery. The BATFET is fully conducting by BATDRV being driven high through a charge pump to VBAT plus VPUMP. The charge pump features a very low bias current when maintaining BATDRV high. This current is accounted for in the core quiescent current. When the application is operating without any charger attached, the battery FET is by default fully conducting when the VBAT is greater than the undervoltage threshold UVLO while non-conducting for lower voltages (fully depleted battery).

### Adapter Detection and Removal

The AC adapter is connected to the input VIN which is permanently monitored by a set of comparators. A first imprecise low current comparator will detect the presence of an input voltage greater than VINDET. This comparator is always enabled even when the core of the circuit is in off mode. Once detected, the more precise input voltage detectors are enabled.

The precise voltage detectors will validate if the applied charger is in the proper input range bounded by VINLO (on VSEL pin) and VINOV (on VIN pin) or VINMINOK depending on VINOK\_SEL (see SMBUS Registers Map). To guarantee a robust detection, debounce timers are added to the VINLO detection. The VINOV acts as an overvoltage protection that rejects too high voltage chargers in order to avoid damage to the application.

### VINOK Output

When the input voltage is valid ( $VSEL > VINLO$  and  $VIN < VINOV$ ) or ( $VINMINOK < VIN < VINOV$ ) depending on VINOK\_SEL bit (register MinSysVoltage), the open drain VINOK pin is released and pulled high by the external pull up resistor thus signaling the host that a valid supply is attached. When becoming invalid the opposite applies.

The SMBus doesn't have a slave interrupt feature. To inform the host about an event a sideband signal is to be used. On the NCP1871 the VINOK pin flags to the host when a valid charger is attached. Given the non critical timing of the VINOK signal for this use case, an interrupt is signaled as a short 'not VINOK' pulse. The short period of the pulse allows distinguishing an interrupt from a charger removal. An interrupt can only be generated when a valid charger is attached. The interrupt feature can be enabled and disabled through the control bus (Bit FAULT\_MSK and STATUS\_MSK, Register ChargeOption2). Register Interrupt inform the system about the nature of interruption.

| I <sup>2</sup> C Signal | Nature           | Flagged on VINOK | Associated Mask Bit | Description                                             |
|-------------------------|------------------|------------------|---------------------|---------------------------------------------------------|
| EOC_INT                 | RC Dual Edge     | Yes              | STATUS_MSK          | 0: Not in End of Charge state<br>1: End of charge state |
| PRE_INT                 | RC Dual Edge     | Yes              | STATUS_MSK          | 0: Not in Precharge State<br>1: Precharge state         |
| LEARNB_INT              | RC Dual Edge     | Yes              | STATUS_MSK          | 1: Enter/Exit Learn Mode                                |
| WDOG_INT                | RC Single Edge   | Yes              | STATUS_MSK          | 1: Wd timer expired                                     |
| IPEAK_INT               | RC Single Edge   | Yes              | FAULT_MSK           | 1: IPKMAX reached.                                      |
| INOVP_INT               | RC Dual Edge     | Yes              | FAULT_MSK           | 0: INOVP = 0<br>1: INOVP = 1                            |
| BUCK_OVP_INT            | RC Dual Edge     | Yes              | FAULT_MSK           | 0: BUCKOV = 0<br>1: BUCKOV = 1                          |
| SYSOV_INT               | Write 1 to Clear | Yes              | FAULT_MSK           | 1: SYSOV                                                |
| HW_RST_INT              | RC Single Edge   | No               | NA                  | 1: HW_RST state <b>and</b> HW_RST=1                     |
| BAT_DIS_INT             | RC Single Edge   | No               | NA                  | 1: HW_RST state <b>and</b> BAT_DIS=1                    |
| INSHORT_INT             | No Clear         | Yes              | FAULT_MSK           | 1: INSHORT = 1                                          |
| BAT_RMV_INT             | RC Single Edge   | Yes              | STATUS_MSK          | 0: Battery is present<br>1: Battery is removed          |

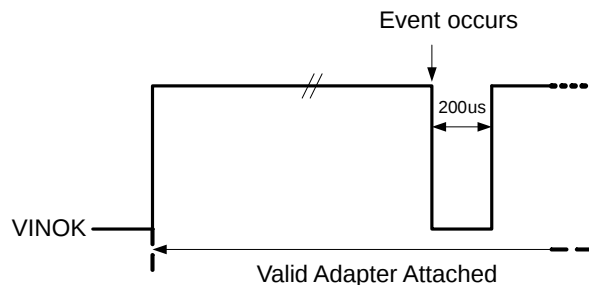


Figure 9. Interrupt Signaling

### Battery Removal

A battery removal pin TS can be used to monitor battery presence. This allows the charger to anticipate a potential voltage drop of the system rail in case of battery removal. If a battery is suddenly removed, a PRHOTB is immediately generated, informing the system that the battery is no longer available for supplement. If this event appears during learn mode, the buck is immediately forced to VCHG. The PRHOTB length is 10 ms allowing enough time for the system to take into account this event, and adapt its power management accordingly.

### VSYSMIN Default Value Detection

User can select the VSYSMIN default value thanks to an external resistor RCELL. The resistance should be put in series with VSEL pin as follows:

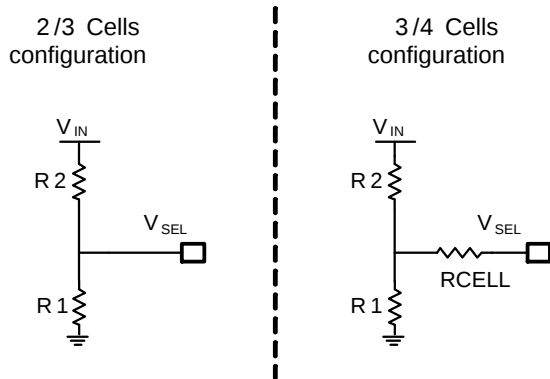


Figure 10. Resistor Network for CELL Detection

RCELL must be 220 k $\Omega$  if 3/4 cells config selected. R1 is also fixed to 22 k $\Omega$ , and R2 is used to select VINOK threshold. The following table illustrates VINOK versus R2.

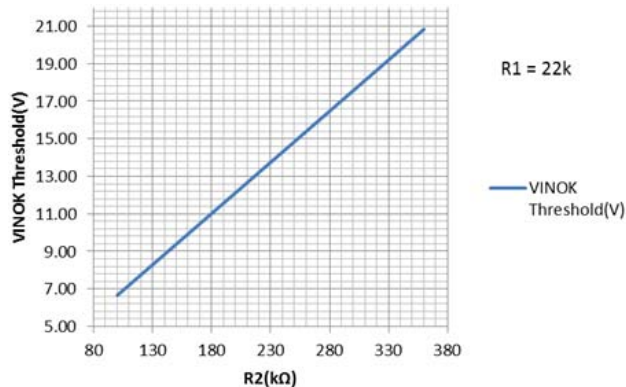


Figure 11. VINOK versus R2 Table

This function can be defeated through I<sup>2</sup>C (bit N\_CELL\_EN, register MinSysVoltage).

### Upfront Protection

To avoid the battery voltage supplying the AC adapter input pin, a reverse blocking element is required. One could use a Schottky diode but given the high current levels in play, the dissipation would be excessively high and overall efficiency degraded. This is resolved by using a reverse blocking FET (RBFET) function that simulates an ideal diode. The RBFET is an NMOS type and its gate driven from RBDRV. An internal charge pump will provide a RBDRV drive voltage of VIN plus V<sub>CORE</sub>.

When attaching a charger, the DC to DC converter is not yet operational and the system is isolated from the charger by the DC to DC converter high side switch. Therefore, upon attachment the capacitive loading seen from the battery charger through the body diode of the RBFET remains

limited to the capacitor at ACSP. It is therefore thought that a back to back configuration of a reverse blocking FET RBFET with an input FET ACFET is not necessarily required. By using a back to back FET configuration however, the charger can be isolated from the application thus providing additional protection against system short circuits and overvoltages. A back to back FET combination also allows connecting some additional charging related circuitry just right after the input FETs while taking advantage of the overvoltage protection.

When a system short circuit occurs that exceeds the input and peak to peak current limits, the RBDRV pin will be made low and the charger will have to be removed to unlatch this condition. When exceeding the system overvoltage threshold VSYSOV, SYSOV\_INT bit will be triggered as system over voltage, need to Write 1 to Clear this bit and release this protection.

For effective isolation the ACFET will have to be added to create a back to back configuration with the RBFET. Both mechanisms add additional safety in case the DC to DC converter does not manage to limit the voltage or current due to for instance a shorted high side switch or other malfunctioning.

### Learn Mode

The NCP1871 provides a special battery learning cycle that helps to calibrate the battery fuel gauge. This cycle is performed while an adapter is attached. Upon the SMBus LEARN command the DC to DC converter is immediately forced to VSYSMIN+VSYSOFF, so the application would be supplied from the battery therefore discharging the latter. When LEARN is finished (normally by fuel gauge) or battery is removed, the charge can resume normally.

### Constant Power Exit

In case a PRHOTB generation is not sufficient to stop the voltage drop during a very strong load transient, some AC adapters are designed to provide more power than their nominal value. In that case, the charger must disable the input current limit to allow full power to flow through it. This mode is enabled thanks to CPEXIT\_EN bit in register ChargeOption2. If this bit is set to 1, the input current limit will immediately be disabled during PRHOTB generation. As soon as PRHOTB disappears, the input current limit is enabled again.

### AC Adapter Overvoltage Protection

In case of an overvoltage, the DC to DC converter is immediately disabled and the RBDRV pin made low, so a-synchronously with the core logic. The converter and RBDRV are enabled again when the overvoltage condition disappears. The converter is definitely disabled by the core logic and the charger rejected when the overvoltage condition persists. When connecting an AC adapter, transient voltages greater than the maximum ratings of the IC can occur. Appropriate filtering will have to be placed upfront to stay below these levels.

### Hard System Reset

A hard system reset is initiated after the user has pressed the power button for a long period, usually 8 seconds. The keyboard controller can then through SMBus program the system reset bit after which the BATDRV pin is temporarily made low to GND and the system reset bit cleared. To totally isolate the battery pack from application, back to back configuration of BATFET will be needed. Upon HW\_RST bit is set to 1, a RST\_TMR timer is launched and BATFETs are made non conducting when this timer is expired. This RST\_TMR timer ensures the system can turn off correctly after HW\_RST bit is set 1. The Timer also determines the BATFET OFF duration.

### Battery Disconnect

In web tablets and ultrabooks, the battery pack is embedded and is shipped while being partially charged. To avoid the battery getting slowly discharged by the application while being on the shelf, the battery pack is totally isolated from the application by adding a second MOS in a back to back configuration. By setting the battery disconnect bit through SMBus, after a delay of RST\_TMR, the BATDRV pin will be made low to GND when the adapter is removed and will be kept low as long as the battery power remains available. To exit this state a valid charger will have to be inserted which will reconnect the battery pack and reset the disconnect bit.

### Serial Interface (SMBUS)

The device is widely programmable through the SMBus interface. The SMBus is based on the I<sup>2</sup>C interface with some exceptions. These exceptions are documented in the SMBus specification 2.0 that is available at [smbus.org](http://smbus.org). The I<sup>2</sup>C specification is available from the NXP website or through [i2c-bus.org](http://i2c-bus.org).

The SMBus implementation on the NVDC charger is I<sup>2</sup>C friendly allowing it to be used on non SMBus applications. The most noticeable differences between the two standards to the NVDC charger are listed below.

For SMBus the SDA and SCL logic low and high levels are defined as absolute voltages, where they are relative to the supply for I<sup>2</sup>C. Although specification wise this may lead to conflicting situations, in practice this does not cause an issue when operating from 3 V and 5 V supply rails. The interface of the NCP1871 uses absolute levels and is supplied by the bus lines itself.

For SMBus the clock frequency is within 10 kHz and 100 kHz where I<sup>2</sup>C allows for 0 Hz while in the widespread fast mode it can run up to 400 kHz.

The minimum clock frequency for SMBus allows for implementing a bus timeout mechanism. When the master keeps the bus clock low the slave will release the data lines and the transaction is aborted (equivalent to an I<sup>2</sup>C STOP command).

Limiting the clock frequency of the interface to the SMBus standard could lead to conflicts on an I<sup>2</sup>C bus. The NCP1871 therefore supports up to 400 kHz. This has no side effects on the SMBus operation itself. Note that the bus clocking is independent from the core logic clocking.

For SMBus a slave should always ACK its device address but is allowed to NACK after any of the data bytes. On I<sup>2</sup>C one is allowed to NACK the address. The NCP1871 will actually never respond with a NACK and therefore always provide an ACK.

A smart battery charger on a SMBus has an imposed bus address of 0001001b. Optionally, the NCP1871 includes a different I<sup>2</sup>C address (available upon request).

The smart battery charger protocol imposes a word (low byte, high byte) write/read protocol with one address per 2 bytes. In I<sup>2</sup>C, the single byte write/read is more common where each byte of data has its own individual address. However, most I<sup>2</sup>C masters can perform an auto increment to perform a 2 bytes consecutive write/read starting with the low byte, also see the appendix. The diagram below summarizes this.

Write Word Protocol Format

| Start | Slave Address | W | ACK | Register Address | ACK | LowData Byte | ACK | High Data Byte | ACK | Stop |
|-------|---------------|---|-----|------------------|-----|--------------|-----|----------------|-----|------|
|       | 0001001       | 0 | 0   | [7:0]            | 0   | [7:0]        | 0   | [15:8]         | 0   |      |

Read Word Protocol Format

| Start | Slave Address | W | ACK | Register Address | ACK | Start | Slave Address | R | ACK | LowData Byte | ACK | High Data Byte | NACK | Stop |
|-------|---------------|---|-----|------------------|-----|-------|---------------|---|-----|--------------|-----|----------------|------|------|
|       | 0001001       | 0 | 0   | [7:0]            | 0   |       | 0001001       | 1 | 0   | [7:0]        | 0   | [15:8]         | 1    |      |

## Application Information

## Typical Application

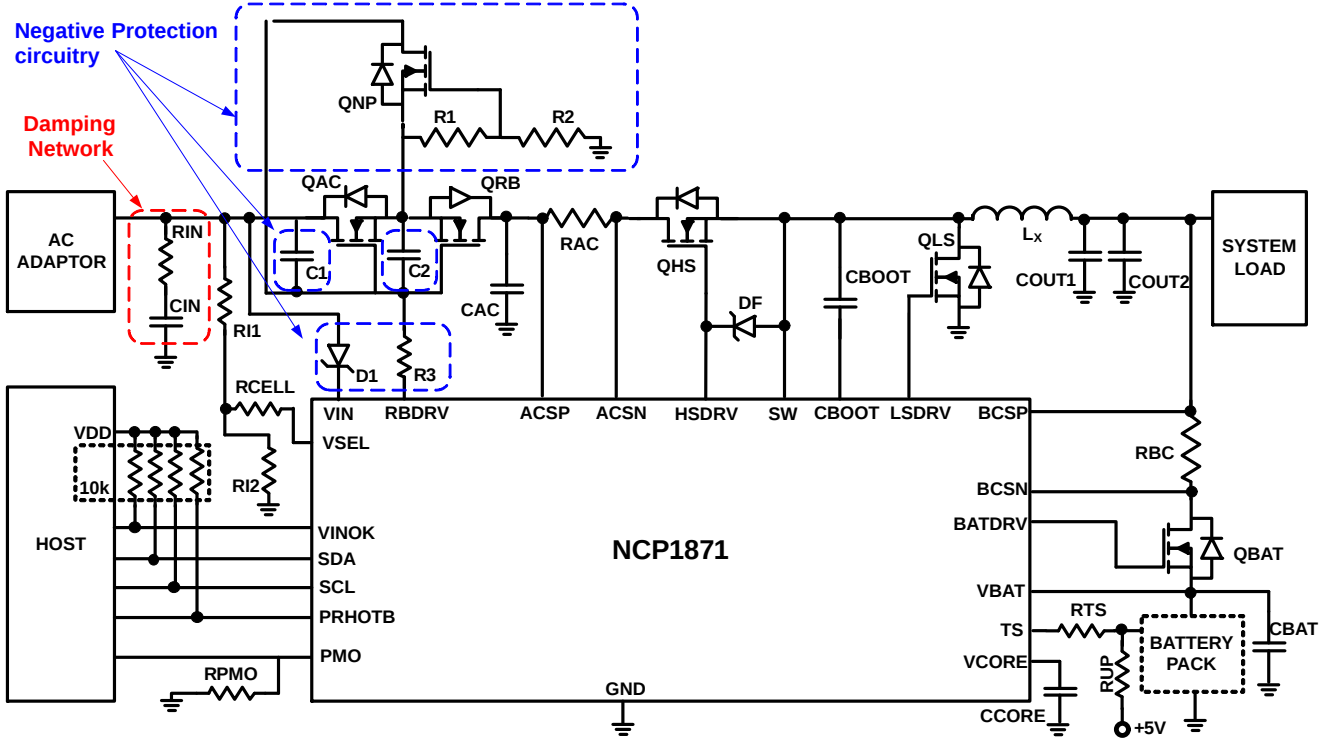


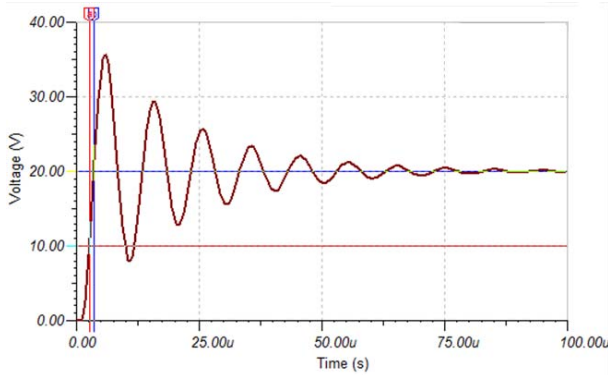
Figure 12. Additional Circuitry for Negative Protection

Table 5. BILL OF MATERIAL

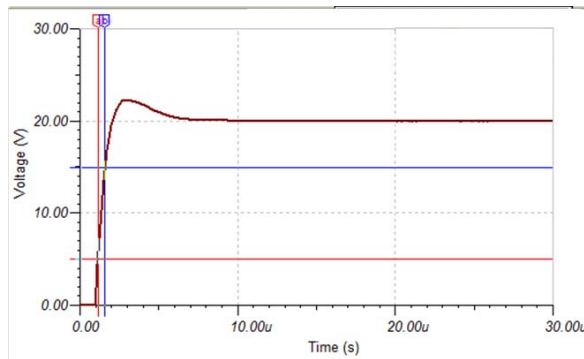
| Reference                                                                                | Description                                         | Manufacturer / Part Number | Value                               |
|------------------------------------------------------------------------------------------|-----------------------------------------------------|----------------------------|-------------------------------------|
| C <sub>IN</sub>                                                                          | Decoupling input capacitor                          |                            | 4.7 $\mu$ F / 50 V                  |
| R <sub>IN</sub>                                                                          | Damping Resistor                                    |                            | 2 $\Omega$ / 0.5 W                  |
| C <sub>AC</sub>                                                                          | Decoupling Switcher capacitor                       |                            | 10 $\mu$ F / 50 V                   |
| C <sub>BOOT</sub>                                                                        | Bootstrap capacitor                                 |                            | 100 nF / 25 V                       |
| C <sub>CORE</sub>                                                                        | Decoupling core supply capacitor                    |                            | 2.2 $\mu$ F / 6.3 V                 |
| C <sub>OUT1</sub> , C <sub>OUT2</sub>                                                    | Decoupling system capacitor                         |                            | 47 $\mu$ F / 25 V                   |
| C <sub>BAT</sub>                                                                         | Decoupling battery capacitor                        |                            | 10 $\mu$ F / 50 V                   |
| D <sub>F</sub>                                                                           | Clamping Schottky Diode                             | MBRM120E / ONSEMI          | 20 V / 1 A                          |
| L <sub>X</sub>                                                                           | Switcher Inductor                                   | IHLP-2525CZ-01 / VISHAY    | 2.2 $\mu$ H / 8 A                   |
| R <sub>AC</sub> , R <sub>BC</sub>                                                        | Current sense resistor                              |                            | 10 m $\Omega$ / 1 W                 |
| Q <sub>AC</sub> , Q <sub>RB</sub> , Q <sub>HS</sub> , Q <sub>LS</sub> , Q <sub>BAT</sub> | Power MOSFET N-channel                              | NTTFS4C10N / ONSEMI        | 10 m $\Omega$ / 30 V                |
| R <sub>TS</sub>                                                                          | Battery Hotplug Current Limit Resistor              |                            | 1 k $\Omega$ / 0.1 W                |
| R <sub>UP</sub>                                                                          | Battery Removal Pull Up resistor                    |                            | 100 k $\Omega$ / 0.1 W              |
| R <sub>1</sub>                                                                           | Q <sub>RB</sub> Reverse protection biasing resistor |                            | 3.01 M $\Omega$ / 0.25 W            |
| R <sub>2</sub>                                                                           | Q <sub>RB</sub> Reverse protection biasing resistor |                            | 1 M $\Omega$ / 0.25 W               |
| R <sub>3</sub>                                                                           | R <sub>BDRV</sub> Reverse protection resistor       |                            | 4 k $\Omega$ / 0.5 W                |
| R <sub>PMO</sub>                                                                         | Power Monitor Resistor                              |                            | 33 k $\Omega$ / 0.1 W               |
| C <sub>1</sub>                                                                           | Reverse protection capacitor                        |                            | 2.2 nF / 50 V                       |
| C <sub>2</sub>                                                                           | Reverse protection capacitor                        |                            | 0.1 $\mu$ F / 50 V                  |
| Q <sub>NP</sub>                                                                          | Reverse protection NMOS                             | 2N7002L / ONSEMI           | 7.5 $\Omega$ / 60 V                 |
| D <sub>1</sub>                                                                           | Schottky Barrier Rectifier                          | MBRA340T3G / ONSEMI        | 3 A / 40 V                          |
| R <sub>I1</sub> , R <sub>I2</sub>                                                        | Minimum input voltage valid resistor                |                            | See VSYSMIN Default Value Detection |
| R <sub>CELL</sub>                                                                        | Number of cell selection resistor                   |                            |                                     |

### Input Damping Network

A Damping network is recommended in order to avoid voltage ringing on the input. On the following example (see Figure 13) with a  $1\ \mu\text{H} / 0.1\ \Omega$  cable, the maximum input voltage is higher than 30 V and can damage the application. In Figure 14, a damping network  $1\ \mu\text{F} / 2\ \Omega$  is added so the input voltage is smoothed to 22–24 V maximum.



**Figure 13. Hot Plug Behavior without Damping Network**



**Figure 14. Hot Plug Behavior with Damping Network**

### Input Negative Protection

A negative voltage protection on input is defined by the negative protection circuitry (see Figure 12). In normal operation,  $Q_{NP}$  is off ( $V_{GS} < 0\ \text{V}$ ).  $D1$  is conducting and  $R1$ ,  $C1$  and  $C2$  have no continuous effect. When adapter voltage is reversed,  $Q_{NP}$   $V_{GS}$  is positive causing  $Q_{NP}$  to turn on. As a consequence, the source and gate node of  $Q_{RB}$  is shorted so  $Q_{RB}$  is off and the battery side circuitry is protected by the body diode of  $Q_{RB}$ . At the same time,  $D1$  is protecting input

charger circuitry by blocking the negative voltage and  $R3$  limits the current flowing into the ESD protection circuitry thus avoiding damage.  $C1$  and  $C2$  ensure the  $V_{GS}$  of  $Q_{RB}$  and  $Q_{AC}$  remains 0 V during negative hot plug.

### Components Selection

#### Inductor Selection

Inductor electrical selection depends on maximum current, frequency and duty cycle. The saturation and DC current are defined by:

$$I_{SAT} = I_{CHG} + 0.5 \times I_{RIPPLE}$$

The inductor ripple current depends on input voltage ( $V_{IN}$ ), duty cycle ( $D = V_{OUT} / V_{IN}$ ), switching frequency ( $F_{SWCHG}$ ) and inductance ( $L_X$ ):

$$I_{RIPPLE} = \frac{(V_{IN} \times D \times (1 - D))}{(F_{SWCHG} \times L_X)}$$

The maximum inductor ripple current happens for  $D = 0.5$

$I_{RIPPLE} = V_{IN} / (4 \times F_{SWCHG} \times L_X)$  So maximum current is given by  $I_{SAT} = I_{CHG} + 0.5 \times V_{IN} / (4 \times F_{SWCHG} \times L_X)$

Please note that the NCP1871 switching frequency is selectable.

#### Power MOSFETs Selection

NCP1871 is designed to drive N-Channel MOSFET with 5 V gate drive voltage and an operating voltage up to 24 V. Due to voltage transient, a 30 V N-MOSFET is preferred.  $Q_{AC}$ ,  $Q_{RB}$ ,  $Q_{HS}$ ,  $Q_{LS}$  and  $Q_{BAT}$  are all N-Channel MOSFET and can be identical. It is also recommended to select a very low  $R_{DS(on)}$  MOSFET (10 m $\Omega$  typically for  $V_{GS} = 4.5\ \text{V}$ ) with a total gate charge around 10 nC typically. NTTFS4C10N from ON SEMICONDUCTOR is the perfect fit with NCP1871.

For  $Q_{BAT}$ , one more thing needs mention: since BATDRV would be pulled low to GND during shipping mode or hard system reset action, which means  $V_{GS}$  at this time would be ( $-V_{BAT}$ ), the NFET needs to be selected with enough  $V_{GS}$  rating especially for 3 or 4 cells application.

#### PCB Layout Recommendation

Proper layout of the components is recommended in order to minimize high frequency current path loop and to prevent high frequency resonant problems and electrical magnetic field radiation.

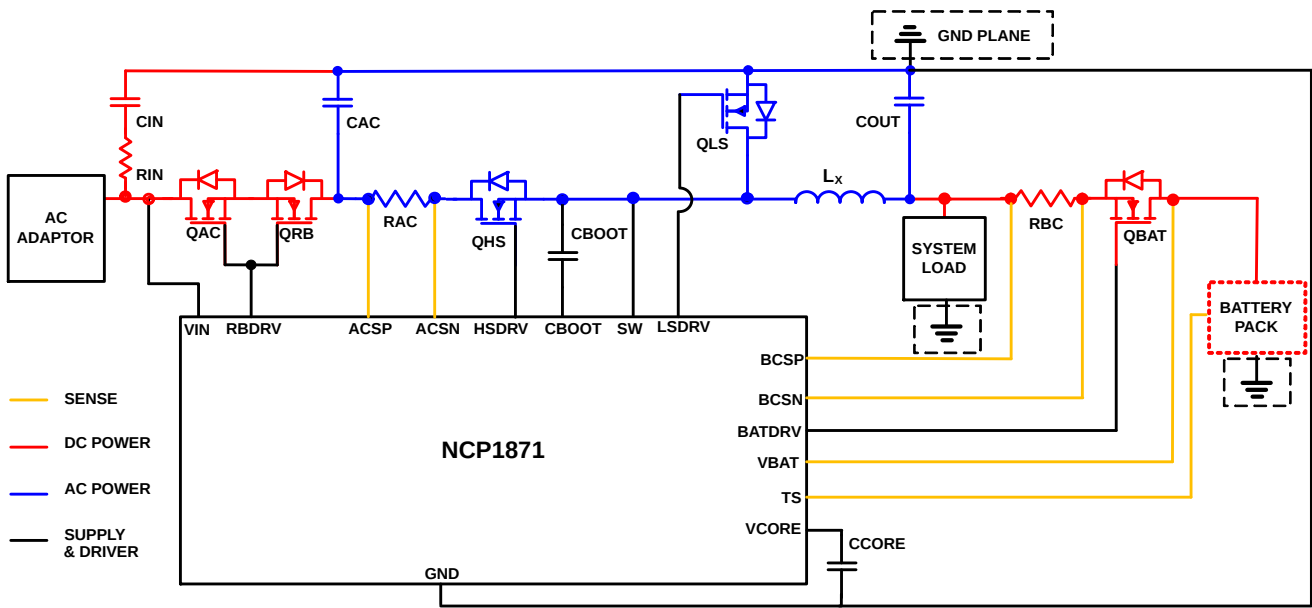


Figure 15. Typical Layout Recommendation

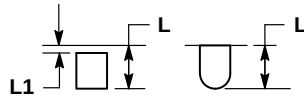
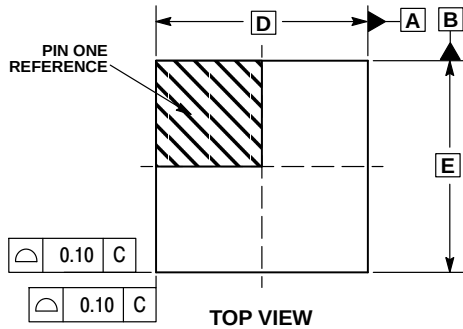
It is crucial to take the following rules into account.

- The switching loop (AC power track) composed by  $C_{AC}$ ,  $R_{AC}$ ,  $Q_{HS}$ ,  $Q_{LS}$ ,  $L_X$ ,  $C_{OUT}$  must be as short as possible and placed on the same layer of PCB. This track must be isolated from GND plane, only  $C_{OUT}$  cold node is connected to the GND plane. This track must be large enough to reduce impedance of track (8 A typ).
- The impedance of DC power track composed by  $Q_{AC}$ ,  $Q_{RB}$ ,  $R_{BC}$  and  $Q_{BAT}$  must be as low as possible and placed on the same PCB layer as the AC power track. This track also must be large enough (8 A typ).
- $C_{CORE}$  Capacitor must be placed as close as possible to the IC and routed on the same PCB layer as the IC. The connection to GND (expose pad) should be short and connected to  $C_{OUT}$  cold node with a unique track.
- Use Kelvin connection for  $R_{AC}$  and  $R_{BC}$  sensing and do not route these sense leads through a high  $di/dt$  or  $dv/dt$  path.
- Supply and driver track must be large enough (1 A max).  $LS DRV$  and  $HS DRV$  are switching nodes; track must be shortened to reduce parasitic inductance.

# NCP1871

## PACKAGE DIMENSIONS

QFN20 3.5x3.5, 0.5P  
CASE 485CP  
ISSUE O

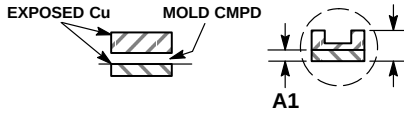
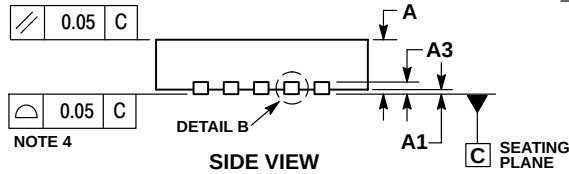


DETAIL A  
ALTERNATE TERMINAL  
CONSTRUCTIONS

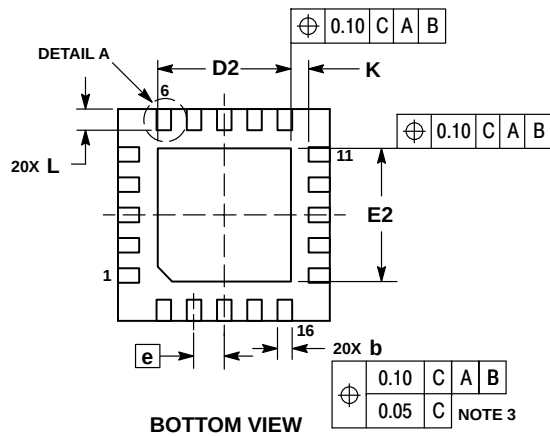
### NOTES:

1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
2. CONTROLLING DIMENSION: MILLIMETERS.
3. DIMENSION b APPLIES TO PLATED TERMINAL AND IS MEASURED BETWEEN 0.15 AND 0.30 MM FROM TERMINAL TIP.
4. COPLANARITY APPLIES TO THE EXPOSED PAD AS WELL AS THE TERMINALS.

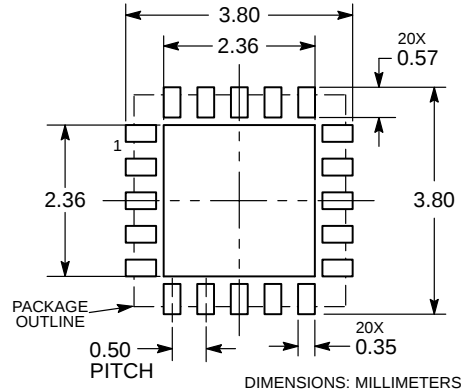
| MILLIMETERS |      |      |
|-------------|------|------|
| DIM         | MIN  | MAX  |
| A           | 0.80 | 1.00 |
| A1          | —    | 0.05 |
| A3          | 0.20 | REF  |
| b           | 0.20 | 0.30 |
| D           | 3.50 | BSC  |
| D2          | 2.10 | 2.30 |
| E           | 3.50 | BSC  |
| E2          | 2.10 | 2.30 |
| e           | 0.50 | BSC  |
| K           | 0.30 | REF  |
| L           | 0.25 | 0.45 |
| L1          | 0.00 | 0.15 |



DETAIL B  
ALTERNATE  
CONSTRUCTIONS



### RECOMMENDED MOUNTING FOOTPRINT



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